

# Please note that Cypress is an Infineon Technologies Company.

The document following this cover page is marked as "Cypress" document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

# Continuity of document content

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

# Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.



CapSense Express Controllers with SmartSense Auto-tuning - 16 Buttons, 2 Sliders, Proximity Sensors

# General Description

The CY8CMBR3xxx CapSense<sup>®</sup> Express™ controllers enable advanced, yet easy-to-implement, capacitive touch sensing user interface solutions. This register-configurable family, which supports up to 16 capacitive sensing inputs, eliminates time-consuming firmware development. These controllers are ideal for implementing capacitive buttons, sliders, and proximity sensing solutions with minimal development-cvcle times.

The CY8CMBR3xxx family features an advanced analog sensing channel and the Capacitive Sigma Delta PLUS (CSD PLUS) sensing algorithm, which delivers a signal-to-noise ratio (SNR) of greater than 100:1 to ensure touch accuracy even in extremely noisy environments. These controllers are enabled with Cypress's SmartSense™ Auto-tuning algorithm, which compensates for manufacturing variations and dynamically monitors and maintains optimal sensor performance in all environmental conditions. In addition, SmartSense Auto-tuning enables a faster time-to-market by eliminating the time-consuming manual tuning efforts during development and production ramp-up.

Advanced features, such as LED brightness control, proximity sensing, and system diagnostics, save development time. These controllers enable robust liquid-tolerant designs by eliminating false touches due to mist, water droplets, or streaming water. The CY8CMBR3xxx controllers are offered in a variety of small form factor industry-standard packages.

The ecosystem for the CY8CMBR3xxx family includes development tools—software and hardware—to enable rapid user interface designs. For example, the EZ-Click Customizer tool is a simple graphical user interface software for configuring the device features through the I<sup>2</sup>C interface. This tool also supports CapSense data viewing to monitor system performance and support validation and debugging. Another tool, the Design Toolbox, simplifies circuit board layout by providing design guidelines and layout recommendations to optimize sensor size, trace lengths, and parasitic capacitance. To guickly evaluate the CY8CMBR3xxx family features, use the CY3280-MBR3 Evaluation Kit.

# Features

- Register-configurable CapSense Express controller
  - No firmware development required
  - Patented CSD sensing algorithm
  - □ High sensitivity (0.1 pF)
    - · Overlay thickness of up to 15 mm for glass and 5 mm for plastic
    - · Proximity solutions
    - · Sensitivity up to 2 fF per count
  - □ Best-in-class >100:1 SNR performance
    - · Superior noise-immunity performance against conducted and radiated noise
    - Ultra-low radiated emissions
  - SmartSense Auto-tuning
    - · Sets and maintains optimal sensor performance during run time
    - · Eliminates manual tuning during development and production
- Low-power CapSense
  - Average current consumption of 22 µA per sensor at 120-ms refresh interval
  - □ Wide parasitic capacitance (C<sub>P</sub>) range: 5–45 pF
- Advanced user interface features
  - Liquid tolerance
  - User-configurable LED brightness for visual touch feedback Up to eight high-sink current GPOs to drive LEDs
  - Buzzer signal output for audible touch feedback

- □ Flanking Sensor Suppression (FSS) to eliminate false touches in closely spaced buttons
- Analog voltage output
- Attention line interrupt to the host to indicate any change in sensor status
- System diagnostics to detect
  - Improper value of the modulating capacitor (CMOD)
  - $\Box$  Out of range sensor parasitic capacitance (C<sub>P</sub>)
- □ Sensor shorts
- EZ-Click<sup>™</sup> Customizer tool
  - Simple GUI for device configuration
  - Data viewing and monitoring for CapSense buttons, sliders, and proximity sensors
  - System diagnostics for rapid debug
- I<sup>2</sup>C slave
  - □ Supports up to 400 kHz
  - Wake-on-hardware address match
  - No bus-stalling or clock-stretching during transactions
- Low-power 1.71-V to 5.5-V operation
- Deep Sleep mode with wake-up on interrupt and I<sup>2</sup>C address detect
- Industrial temperature range: -40 °C to +85 °C
- Package options

8-pin SOIC (150 mil) 16-pin SOIC (150 mil) 16-pin QFN (3 × 3 × 0.6 mm) □ 24-pin QFN (4 × 4 × 0.6 mm)

Cypress Semiconductor Corporation

**198 Champion Court** 

Document Number: 001-85330 Rev. \*Q



# **More Information**

Cypress provides a wealth of data at www.cypress.com to help you to select the right CapSense device for your design, and to help you to quickly and effectively integrate the device into your design. For a comprehensive list of resources, see the knowledge base article KBA92181, Resources Available for CapSense® Controllers. Following is an abbreviated list for CapSense devices:

- Overview: CapSense Portfolio, CapSense Roadmap
- Product Selectors: Refer to the "CapSense Selector Guide" chapter in the Getting Started with CapSense design guide.

## CY8CMBR3xxx Ecosystem

Cypress provides a complete ecosystem to enable a quick development cycle with the CY8CMBR3xxx CapSense controller family. This ecosystem includes simple tools for device configuration, design validation, and diagnostics.

#### Documentation

#### Design Guides

Design guides are an excellent introduction to a variety of possible CapSense-based designs. They provide an introduction to the solution and complete system design guidelines. Refer to the following design guides for CY8CMBR3xxx:

- 1. Getting Started with CapSense an ideal starting point for all CapSense users
- 2. CY8CMBR3xxx CapSense Design Guide provides complete system design guidelines for CY8CMBR3xxx

You can download these design guides from our website: www.cypress.com/go/capsense.

#### Registers TRM

The CY8CMBR3xxx Registers TRM lists and details all the registers of the CY8CMBR3xxx family of controllers in order of their addresses. These registers may be accessed through an  $I^2C$  interface with the host.

#### Software Utility

#### EZ-Click Customizer Tool

The EZ-Click Customizer Tool is a simple, GUI-based software utility that can be used to customize the CY8CMBR3xxx device configurations.

Use this GUI-based tool to do the following:

- 1. Select the appropriate part number based on an end-application requirement using the Product Selector
- 2. Configure the device features
- 3. Observe CapSense data for button and proximity sensors
- 4. Use the System Diagnostics and built-in test self-test (BIST) features for debug and production-line testing

Figure 1. Configuring CY8CMBR3xxx using Ez-Clic	Figure 1.	Configuring	CY8CMBR3xxx	using	<b>Ez-Click</b>
---	-----------	-------------	-------------	-------	-----------------

Present survey       Out of the second period       Out of the second period<	Maturality       Maturality <th>And the second second</th> <th></th> <th>-</th> <th></th> <th></th> <th></th> <th></th> <th></th> <th></th> <th>the second se</th> <th></th> <th></th> <th></th> <th>apSense output   S</th> <th></th> <th></th> <th></th> <th></th> <th></th>	And the second second		-							the second se				apSense output   S					
Button:       Image: Creation of the second of	Image: Control to the problem of th		0.	-		Buttons SI	liders LED				02/19/102022		0 -	A DECEMBER OF CONTRACT	Contract of the second s		All and a second se	period (ms):	120	
BP:       CCCCADD(21)       0       0       False       Pn       Sensor       Sensor       Formal-2       0       0       2       0	Image: Construction in the construction of the construc	uttoos	0		and the second se						number of	proximity sensors:	0	1 cm	K=1/32	10000	- 20			500
Dec       D	Image: Control Contente Control Control Control Control Control		Lines.	121		0 0	10	0	0	Entra	Buttom									
Devices Needed       0       - Org. Needed       10       120       100       120       100       100       100       100	Image: Section 2       Image: Section 2 <th< td=""><td>EDs:</td><td>0</td><td>•</td><td></td><td>~</td><td>140</td><td>14</td><td>10</td><td>race</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>Initial Resonnse</td><td>Subsequer</td></th<>	EDs:	0	•		~	140	14	10	race									Initial Resonnse	Subsequer
Biters sheld <ul> <li>Critic MB322</li> <li>Diversibility</li> <li>Biters dive</li> <li>Critic MB322</li> <li>Diversibility</li> <lidi< td=""><td>a ment       1       1       2       True         - CHECAMERIZED       1       0       1       2       True       10       13       10       0       0         - CHECAMERIZED       10       0       1       10       13       100       10       13       100       0       10<td>oximity sensors</td><td>0</td><td>•</td><td>and the second s</td><td></td><td>12</td><td>0</td><td>0</td><td>False</td><td>Enable</td><td>Pin</td><td></td><td>Sensor</td><td>Sensitivity (</td><td>fF)</td><td>Finger Threshold</td><td>FSS</td><td>Time (ms)</td><td></td></td></lidi<></ul>	a ment       1       1       2       True         - CHECAMERIZED       1       0       1       2       True       10       13       10       0       0         - CHECAMERIZED       10       0       1       10       13       100       10       13       100       0       10 <td>oximity sensors</td> <td>0</td> <td>•</td> <td>and the second s</td> <td></td> <td>12</td> <td>0</td> <td>0</td> <td>False</td> <td>Enable</td> <td>Pin</td> <td></td> <td>Sensor</td> <td>Sensitivity (</td> <td>fF)</td> <td>Finger Threshold</td> <td>FSS</td> <td>Time (ms)</td> <td></td>	oximity sensors	0	•	and the second s		12	0	0	False	Enable	Pin		Sensor	Sensitivity (	fF)	Finger Threshold	FSS	Time (ms)	
CRCMERSIDES       1       0       1       2       True       1       CCCVCARSIDES       100       120       100       120       100         Bruser drive       CCRCARSIDES       0       4       1       2       True       1       CCRCARSIDES       100       120       100       120       100         Bruser drive       CCRCARSIDES       0       8       2       True       1       CCRCARSIDES       100       120       100       120       100       120       100       120       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       100       120       100       120       100       120       100       120       100       120       100       120       100       120       100       120       100       120       100       120       <	Image: Construction of a b c construlation of a b c construlation of a b c construction of a b c cons	Distant shinks					1				11	CS0/PS0 (1)	Buttonl		100		128		180	10000
Baser dive       CVECKMB200 8       0       4       1       2       Tree       1       CVECKMB200 10       100       120       10       100       120       10       100       120       100       120       100       120       100       120       100       120       100       120       100       120       100       120       100       100       100 </td <td>Image: control with the second sec</td> <td>, purch sine o</td> <td></td> <td></td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>2</td> <td></td> <td>10</td> <td>CS1/PS1 (2)</td> <td>Button2</td> <td></td> <td>100</td> <td>-</td> <td>128</td> <td>1</td> <td>180</td> <td>60</td>	Image: control with the second sec	, purch sine o			1	1	0	1	2		10	CS1/PS1 (2)	Button2		100	-	128	1	180	60
Domming effects       CVBCMB2310       10       0       5       1       2       True       CVBCMB2316       100       120       13       13         Gard sensor       LED internity control       CVBCMB2316       140       0       1       2       100       13       14       13       14 <td>reres          <ul> <li>C49C-0460332</li> <li>Dial</li> <li>Dia</li> <li>Dial</li> <lidial< li<="" td=""><td>Buzzer drive</td><td></td><td></td><td>CY8CM8R3108 8</td><td>0</td><td>4</td><td>1</td><td>2</td><td>True</td><td></td><td>CSZ/GUARD (3)</td><td>Button3</td><td></td><td>100</td><td>-</td><td>128</td><td></td><td>160</td><td>60</td></lidial<></ul></td>	reres <ul> <li>C49C-0460332</li> <li>Dial</li> <li>Dia</li> <li>Dial</li> <lidial< li<="" td=""><td>Buzzer drive</td><td></td><td></td><td>CY8CM8R3108 8</td><td>0</td><td>4</td><td>1</td><td>2</td><td>True</td><td></td><td>CSZ/GUARD (3)</td><td>Button3</td><td></td><td>100</td><td>-</td><td>128</td><td></td><td>160</td><td>60</td></lidial<></ul>	Buzzer drive			CY8CM8R3108 8	0	4	1	2	True		CSZ/GUARD (3)	Button3		100	-	128		160	60
I deard sensor       I deard sensor       I deard sensor       I deard sensor         I deard sensor       I deard sensor       I deard sensor       I deard sensor         I deard sensor       I deard sensor       I deard sensor       I deard sensor         I deard sensor       I deard sensor       I deard sensor       I deard sensor         I deard sensor       I deard sensor       I deard sensor       I deard sensor         I deard sensor       I deard sensor       I deard sensor       I deard sensor         age ( depSense sensor configuration ( dobal configuration )       CepSense output ( System diagnostics         I deard sensor         tview:       Button output       Displayed Samples:       1000       I deard sensor         on output       Displayed Samples:       1000       Start       I deard sensor         or uotput       Button status:       Off       Start       I deard sensor       I deard sensor         or uotput       I deard sensor         or uotput       I deard sensor         or uotput       I deard sensor       I deard sensor       I deard sensor       I deard sensor	• conscience 1           • conscience 1         • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscience 1           • conscient conscience 1	Dimming effe	ects		CY8CM8R3110 1	0 0	5	1	2	True		CSF (4)	Button4		100		128		180	60
LED intensity centred LED intensity centred age Capsense sensor configuration Global configuration CapSense output System diagnostics tview: Button output  Displayed Samples: 1000  Sample on: BTN1  Button status: Off Stath or Cp (pF): 8 Graph: Signal to noise ratio Displayed Samples: Signal to noise ratio Displayed	v centrel				CV8CMBR3116 1	6 0	8	1	2	and the second se	13	CS4 (20)	Button5		1	$\triangleleft$	178		180	60
age       CapSense sensor configuration       CapSense output       System diagnostics         iview:       Button output       Displayed Samples:       100       Sample         on output       Displayed Samples:       100       Sample       CapSense consort configuration       100       128       100       128       100       128       100       128       100       128       100       100       128 <td< td=""><td>ense sensor configuration       CapSense output       System diagnostics         into output       Displayed samples:       DOD       Sample         Bitton status:       Off       Sample       Call/OPO (1)       Button (1)       Displayed samples:       DOD       Sample         Bitton status:       Off       Sample       Call/OPO (2)       Button(2)       Button (2)       Button (2)</td><td></td><td></td><td></td><td>10100000000000000000000000000000000000</td><td></td><td></td><td></td><td></td><td></td><td></td><td>CS5 (1.9)</td><td>Button6</td><td></td><td>12</td><td></td><td>28</td><td></td><td>180</td><td>60</td></td<>	ense sensor configuration       CapSense output       System diagnostics         into output       Displayed samples:       DOD       Sample         Bitton status:       Off       Sample       Call/OPO (1)       Button (1)       Displayed samples:       DOD       Sample         Bitton status:       Off       Sample       Call/OPO (2)       Button(2)       Button (2)				10100000000000000000000000000000000000							CS5 (1.9)	Button6		12		28		180	60
Dage Capenes ensor configuration Global configuration CapSense output System diagnostics       Image: CapSense ensor configuration (Gable configuration (CapSense output System diagnostics))       Image: CapSense ensor configuration (CapSense output System diagnostics))         Image: CapSense ensor configuration Help       Image: CapSense ensor configuration (CapSense output System diagnostics))       Image: CapSense ensor configuration (CapSense output System diagnostics))         Image: CapSense ensor configuration Help       Image: CapSense ensor configuration (CapSense output System diagnostics))       Image: CapSense ensor configuration (CapSense output System diagnostics))         Image: CapSense ensor configuration Help       Image: CapSense ensor configuration (CapSense output System diagnostics))       Image: CapSense ensor configuration (CapSense output System diagnostics))         Image: CapSense ensor configuration Help <td>enses sensor configuration       Global configuration       CapSense output       System diagnostics       50       100       128       100       128       100       60         itten output       Displayed Samples:       100       Sample       100       128       100       128       100       60         Itten output       Button status:       Off       Sant       100       128       100       128       100       60         I28       Cp (pF):       8       Graph:       Sant       100       128       100       128       100       60         I28       Cp (pF):       8       Graph:       Sant       100       128       100       128       100       60         I28       Cp (pF):       8       Graph:       Sant       100       128       100       128       100       100       128       100       100       128       100       100       100       100       128       100       100       128       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100&lt;</td> <td>LED intensity</td> <td>control</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>11</td> <td>CS6 (18)</td> <td>Button7</td> <td></td> <td></td> <td></td> <td>28</td> <td></td> <td>180</td> <td>60</td>	enses sensor configuration       Global configuration       CapSense output       System diagnostics       50       100       128       100       128       100       60         itten output       Displayed Samples:       100       Sample       100       128       100       128       100       60         Itten output       Button status:       Off       Sant       100       128       100       128       100       60         I28       Cp (pF):       8       Graph:       Sant       100       128       100       128       100       60         I28       Cp (pF):       8       Graph:       Sant       100       128       100       128       100       60         I28       Cp (pF):       8       Graph:       Sant       100       128       100       128       100       100       128       100       100       128       100       100       100       100       128       100       100       128       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100<	LED intensity	control								11	CS6 (18)	Button7				28		180	60
sage       CapSense sensor configuration       Global configuration       CapSense output       System diagnostics       I       CapSense configuration       100       100       128       I       30         on output       Displayed Samples:       100       Sample       CapSense configuration       100       128       I       30         on output       Button status:       Off       Start       Start       I       CapSense configuration       100       128       I       30         er threshold:       128       Cp (pF):       8       Graph:       Start       I <td>ense sensor configuration       Global configuration       Global configuration       Global configuration       100       128       128       60         taten output       Displayed Samples       100       Sample       Incomparing Sample       100       128       128       128       128       128       60         Itan output       Displayed Samples       100       Sample       Incomparing Sample       Incomparing Sample       100       128       128       128       60       60       60         Itan       Off       Start       Signal to noise ratio       Incomparing Sample       Incomparing Sample       Incomparing Sample       100       128       128       60       60         Ital       Off       Start       Signal to noise ratio       Incomparing Sample       100       128       128       100       128       100       128       100       128       100       128       100       128       100       100       100       128       100       100       100       128       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>11</td> <td>C\$7 (17)</td> <td>Buttona</td> <td></td> <td>10</td> <td></td> <td>128</td> <td></td> <td>180</td> <td>60</td>	ense sensor configuration       Global configuration       Global configuration       Global configuration       100       128       128       60         taten output       Displayed Samples       100       Sample       Incomparing Sample       100       128       128       128       128       128       60         Itan output       Displayed Samples       100       Sample       Incomparing Sample       Incomparing Sample       100       128       128       128       60       60       60         Itan       Off       Start       Signal to noise ratio       Incomparing Sample       Incomparing Sample       Incomparing Sample       100       128       128       60       60         Ital       Off       Start       Signal to noise ratio       Incomparing Sample       100       128       128       100       128       100       128       100       128       100       128       100       128       100       100       100       128       100       100       100       128       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100										11	C\$7 (17)	Buttona		10		128		180	60
age CapSense sensor configuration Global configuration CapSense output Utient Displayed Samples: 1000 Sample CSR/CPO2 (A) Button11 100 228 3 CSR/CPO2 (A) Button11 100 228 100 3 CSR/CPO2 (A) Button11 100 2 128 10 3 CSR/CPO2 (A) Button11 100 2 12 Pass CSR/CPO2 (A) Button12 100 2 Pass CSR/CPO2 (A) Button12 (A) CSR/CPO2 (A) Button12 (A) CSR	ense sensor configuration       Global configuration       Global configuration       Global configuration       100       128       128       60         taten output       Displayed Samples       100       Sample       Incomparing Sample       100       128       128       128       128       128       60         Itan output       Displayed Samples       100       Sample       Incomparing Sample       Incomparing Sample       100       128       128       128       60       60       60         Itan       Off       Start       Signal to noise ratio       Incomparing Sample       Incomparing Sample       Incomparing Sample       100       128       128       60       60         Ital       Off       Start       Signal to noise ratio       Incomparing Sample       100       128       128       100       128       100       128       100       128       100       128       100       128       100       100       100       128       100       100       100       128       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100       100											CS8/GP00 (16)	Button9		300	+	128		380	60
t view Button output on: ETNI Button status: Off Cp (pF): 8 Graph: Start Graph: Sta	Internet output       Displayed Samples:       100       Sample       CSB/0/5PO2 (M)       Button L1       100       L28       180       60         ETN1       Button status:       Off       Start       Start       Signal to noise ratio       Off       CSB/0/5PO2 (M)       Button status:       Discretion       Discretion       Discretion       Discretion       Status:       Status:       Discretion       Status:       Status: <t< td=""><td>oage CapSer</td><td>nse senso</td><td>r config</td><td>uration Global configura</td><td>tion CapSen</td><td>se output S</td><td>ystem diag</td><td>nostics</td><td></td><td></td><td>C\$9/GP01 (15)</td><td>Button10</td><td></td><td>100</td><td>-</td><td>1.28</td><td>0</td><td>1.80</td><td>60</td></t<>	oage CapSer	nse senso	r config	uration Global configura	tion CapSen	se output S	ystem diag	nostics			C\$9/GP01 (15)	Button10		100	-	1.28	0	1.80	60
on output on: BTNI Button status: Off cr (pF): 8 Graph: Start Bignal to noise ratio	Image: State of the status:       Off       State of the status:       State of the status:       State off       Off       State off       State off       Off       State off <t< td=""><td>t view: But</td><td>ton outo</td><td></td><td></td><td></td><td>Displayed Sam</td><td>ples: 10</td><td>000</td><td>Sample</td><td>17</td><td>CS10/GPO2 (14)</td><td>Button11</td><td></td><td>100</td><td>-</td><td>1.28</td><td></td><td>180</td><td>60</td></t<>	t view: But	ton outo				Displayed Sam	ples: 10	000	Sample	17	CS10/GPO2 (14)	Button11		100	-	1.28		180	60
on: ETNL Button status: Off er threshold: 128 Cp (pF): 8 Greph: Signal to noise ratio Cescription Cesc	BINA Button status: Off 128 Cp (pf): 8 Graph: Signal to noise ratio Description Description Description File Configuration Help Starpage CapSense sensor configuration CopSense output System diagnostics Test configuration Global configuration CopSense output System diagnostics result Test mode: Prototype Calibrated Cp: 11 Calibrated SNR: 1 Test configuration Test mode: Prototype Calibrated Cp: 11 Calibrated SNR: 1 Calibrated SNR: 1 C	(Duc	ton outp	ui	•	-	-ispinyen suiti		•	Sumple	1		and a state of the Advention of the later of		100				180	60
er threshold: 128 Cp (pF): 8 Graph: Signal to noise ratio Perception	Image: Cp (pF):       8       Graph:       Signal to noise ratio       Image: Cp (pF):       8       Graph:       Signal to noise ratio         Image: Cp (pF):       8       Graph:								_		11	CS12/GPO4 (12)	Button13		100	×.	128		180	60
er threshold: 128 Cp (pF): 8 Graph: Signal to noise ratio Description	128       Cp (pF):       8       Graph:       Signal to noise ratio       0 Errors       0 Warning       0 Warning       0 Warning         100	on:	BTN1		-	Button sta	tus: Off			Start 🕨	070	22813/08056/2333	RottingTo		100		115	0.00	180	60
11     1 </th <th>Start page       CapSense sensor configuration       Global configuration       CapSense output       System diagnostics         Test configuration       For totype       Calibrated Cp:       1       Calibrated SNR:       1         Test mode:       Prototype       Calibrated Cp:       1       Calibrated SNR:       1       Calculate SNR for:         Image:       Power on self test       Tolerance:       1       -       1       +       14       Image:       Image:         Start page       CapSense sensor configuration       Global configuration       Calibrated SNR:       1       Calculate SNR for:         Image:       Power on self test       Tolerance:       1       +       14       Image:       <t< th=""><th>19 1</th><th></th><th></th><th></th><th>Cp (pF):</th><th>8</th><th>Gr</th><th>aph: Signa</th><th>l to noise ratio</th><th>0 0 Errors</th><th>1 0 Warnings</th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th></t<></th>	Start page       CapSense sensor configuration       Global configuration       CapSense output       System diagnostics         Test configuration       For totype       Calibrated Cp:       1       Calibrated SNR:       1         Test mode:       Prototype       Calibrated Cp:       1       Calibrated SNR:       1       Calculate SNR for:         Image:       Power on self test       Tolerance:       1       -       1       +       14       Image:       Image:         Start page       CapSense sensor configuration       Global configuration       Calibrated SNR:       1       Calculate SNR for:         Image:       Power on self test       Tolerance:       1       +       14       Image:       Image: <t< th=""><th>19 1</th><th></th><th></th><th></th><th>Cp (pF):</th><th>8</th><th>Gr</th><th>aph: Signa</th><th>l to noise ratio</th><th>0 0 Errors</th><th>1 0 Warnings</th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th></t<>	19 1				Cp (pF):	8	Gr	aph: Signa	l to noise ratio	0 0 Errors	1 0 Warnings								
13     Start page CapSense sensor configuration     Global configuration     CapSense output     System diagnostics       11     Test configuration     Global configuration     Calibrated Cp:     11     Calibrated SNR:     1       10     Power on self test     Tolerance:     11     Calibrated SNR:     1       10     Power on self test     Tolerance:     11     Calibrated SNR:     1       10     Sensor Status     SNR     Cp     System diagnostics result       11     Off     N/A     Pass	60       10       10       10       10       10       10       10       12       Pass         60       10       10       10       10       10       12       Pass       11       14       10       10       12       Pass         60       10       150       200       250       300       350       400       450       650       650       650       650       650       650       650       100       14       Pass	19 18 17 16		1		Cp (pF):	8	Gr	aph: Signa	File Co	0 Errors Descriptio	0 Warnings n <u>oce selected</u> Help	U O Notes							
1     Image: Construction of the second	Test mode       Prototype       Calibrated Cp:       1       Calibrated SNR:       1       Calibrated SNR:       1         Power on self test       Tolerance:       1       -       1       +       1       -       Calibrated SNR:       1       Caliculat SNR:       1       Calibrated	19 18 17 16 15				Cp (pF):	8	Gr	aph: Signa	File Coi	Descriptio	n n Help e <sup>a</sup> a a a a	i O Notes							
0     0 <td>Image: Construction of the state of the</td> <td>19 18 17 16 15 14 13</td> <td></td> <td></td> <td></td> <td>Cp (pF):</td> <td>8</td> <td>Gr</td> <td>aph: Signa</td> <td>File Cor 🗊 💼</td> <td>0 0 Errors Descriptio</td> <td>n n Help e<sup>a</sup> a a a a</td> <td>i O Notes</td> <td>configuration   CapS</td> <td>ense output Sys</td> <td></td> <td></td> <td></td> <td></td> <td></td>	Image: Construction of the state of the	19 18 17 16 15 14 13				Cp (pF):	8	Gr	aph: Signa	File Cor 🗊 💼	0 0 Errors Descriptio	n n Help e <sup>a</sup> a a a a	i O Notes	configuration   CapS	ense output Sys					
O     O     O     O     O     O     O     O     I     Tolerance     Tolerance	Cmod test: No faults detected     Shield not m.       50     10     150     200     250     300     350     400     450     500     650     700     650     700     650     700     650     700     650     700     650     700     650     700     700     700     700     700     700	19 18 17 16 15 14 13 0 12				Cp (pF):	8	Gr	aph: Signa	File Cor 🗊 💼	0 0 Errors Descriptio	n in in in in in in in in in i	i O Notes	configuration   CapS	ense output Sys				Sto	op a
B     Cmod test: No faults detected     Shield not en       6     6     6       6     6       6     6       7     6       6     6       6     6       7     7       6     6       7     7       6     6       7     7       6     7       6     7       6     7       7     7       7     7       8     7	Cmod test: No faults detected         Shield not en         System diagnostics result           Sensor         Status         SNR         Cp           BTNL         Off         N/A         8         Pass           BTNL         Off         N/A         10         Pass	19 18 17 16 15 14 13 00 12 12 11				Cp (pF):	8	Gr	aph: Signa	File Cor Start page Test co	0 0 Errors Descriptio No target dev figuration H 0 0 Errors No target dev 0 0 Errors 0	n in in in in in in in in in i	10 Notes		ense output Sys	item (	diagnostics	1		
6     Sensor     Status     SNR     Cp       5     BTN1     Off     N/A     8     Pass       3     BTN2     On     10     12     Pass	Sensor         Status         SNR         Cp           BTNI         Off         N/A         8         Pass           BTNI         Off         N/A         8         Pass           BTNI         Off         N/A         8         Pass           BTNI         Off         N/A         10         Pass           BTNI         Off         N/A         10         Pass           BTNI         Off         N/A         14         Pass	19 18 17 16 15 14 13 12 12 12 12 12 10 10				Cp (pF):	8	Gr	aph: Signa	File Con File Con Start pag Test co Test m	0 Errors Descriptio No target dev figuration H CapSense nfiguration: ode:	0 Warnings 0 Conselected Help eff (a) (b) (c) e sensor configuration (Prototype)	tion Global	alibrated Cp: 11		tem (	diagnostics		Calcula	
5 4 3 8 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	BTNL       Off       N/A       8       Pass         BTNL       Off       N/A       8       Pass         BTNL       Off       N/A       10       12       Pass         BTNL       Off       N/A       10       Pass         BTNL       Off       N/A       10       Pass         BTNL       Off       N/A       14       Pass	19 18 17 16 15 14 13 12 12 10 10 10 10				Cp (pF):	8	Gr	aph: Signa	File Con Start pag Test co Test m V Pon	O Errors     Descriptio     Secriptio	in of Warnings in encoded Help of in the sensor configure Prototype it	tion Global	alibrated Cp: 11 olerance: - 11		tem (	diagnostics		Calcula	
3 BTN2 On 10 12 Pass	50     100     150     200     250     300     350     400     450     500     600     650     700 <td>19         18           17         16           16         15           14         13           14         14           13         11           14         13           17         16           18         11           19         12           11         13           12         11           13         11           14         13           14         14           13         11           14         10           14         10           15         14           16         11           17         12           18         14           19         14           10         14           11         14           12         15           13         12           14         13           15         14           16         14           17         15           18         14           19         14           19         14           10         &lt;</td> <td></td> <td></td> <td></td> <td>Cp (pF):</td> <td>8</td> <td>Gr</td> <td>aph: Signa</td> <td>File Con Start pag Test cc Test m V Pon Crmo</td> <td>CapSense nfiguration F CapSense nfiguration: ode: ver on self tes d test: No faul</td> <td>in in in in in in in in in in</td> <td>ation Global</td> <td>alibrated Cp: 11 olerance: - 11</td> <td>- 244</td> <td>tem ( C Ti</td> <td>diagnostics</td> <td><u>*</u> + 1</td> <td>Calcula</td> <td></td>	19         18           17         16           16         15           14         13           14         14           13         11           14         13           17         16           18         11           19         12           11         13           12         11           13         11           14         13           14         14           13         11           14         10           14         10           15         14           16         11           17         12           18         14           19         14           10         14           11         14           12         15           13         12           14         13           15         14           16         14           17         15           18         14           19         14           19         14           10         <				Cp (pF):	8	Gr	aph: Signa	File Con Start pag Test cc Test m V Pon Crmo	CapSense nfiguration F CapSense nfiguration: ode: ver on self tes d test: No faul	in in in in in in in in in in	ation Global	alibrated Cp: 11 olerance: - 11	- 244	tem ( C Ti	diagnostics	<u>*</u> + 1	Calcula	
	50     100     150     200     250     300     350     400     450     500     600     650     700 <td>Signal to noise ratio</td> <td></td> <td></td> <td></td> <td>Cp (pF):</td> <td>8</td> <td>Gr</td> <td>aph: Signa</td> <td>File Cor Start pag Test co Test m Por Crmo Sensor</td> <td>0 Erron Descriptio Descriptio Figuration F @ @ @ @ @ @ e CapSense nfiguration: ode: ver on self tes d test: No faul Status</td> <td>a 0 Warnings ace selected Help are in in</td> <td>ation Global</td> <td>alibrated Cp: 11 olerance: - 11</td> <td>- 244</td> <td>tem ( C Ti</td> <td>diagnostics</td> <td><u>*</u> + 1</td> <td>Calcula</td> <td></td>	Signal to noise ratio				Cp (pF):	8	Gr	aph: Signa	File Cor Start pag Test co Test m Por Crmo Sensor	0 Erron Descriptio Descriptio Figuration F @ @ @ @ @ @ e CapSense nfiguration: ode: ver on self tes d test: No faul Status	a 0 Warnings ace selected Help are in	ation Global	alibrated Cp: 11 olerance: - 11	- 244	tem ( C Ti	diagnostics	<u>*</u> + 1	Calcula	
	50 100 150 200 250 300 350 400 450 500 550 600 850 700 70	19 18 17 16 15 14 13 13 11 13 13 12 10 9 8 7 6 5 4				Cp (pF):	8	Gr	aph: Signa	File Co. Start pas Test co Test m Pon Cmo Sensor BTN1	O Errori Description     Description     Official and a second description     CapSense     nfiguration =     CapSense     nfiguration:     ode:     ver on self test     No faul     Status     Off     N	a 0 Warnings a	tion Global	alibrated Cp: 11 olerance: - 11	- 244	tem ( C Ti	diagnostics	<u>*</u> + 1	Calcula	
	50 100 150 200 250 300 360 400 450 500 550 600 650 700 700 000 000 000 000 000 000 000 0	19 18 17 16 15 14 13 12 11 10 9 9000 01 9 10 12 13 14 10 9 10 15 14 10 15 14 10 10 15 14 10 10 10 10 10 10 10 10 10 10				Cp (pF):	8	Gr	aph: Signa	File Co. Start pag Test co Test m © Por Cmo Sensor BTN1 BTN2	O Errori Description     Description     Description     Origination +     Origination     Origination     Status     Off     N     On     1	a 0 Warnings b 0	Ponotes     Ponotes     C     T     P     Pass     Pass	alibrated Cp: 11 olerance: - 11	- 244	tem ( C Ti	diagnostics	<u>*</u> + 1	Calcula	
	Time	19 18 17 16 15 11 13 11 10 9 8 7 6 5 4 3 2 1				(p (pF):	8	Gr	aph: Signa	File Con Start pag Test co Test m V Pon Crmo Sensor BTN1 BTN2 BTN3	O Errori Description     Description	a 0 Warnings a 0	P Pass Pass Pass	alibrated Cp: 11 olerance: - 11	- 244	tem ( C Ti	diagnostics	<u>*</u> + 1	Calcula	
		19 18 17 16 15 14 13 12 11 11 13 12 11 10 9 8 7 6 5 4 3 2 1 0		0 150		3	450 <u>600</u> Time	550 600		File Co Start pas Test co Test m Po Crmo Sensor BTN1 BTN2 BTN2 BTN4	O Errori Description     Description	a 0 Warnings a 0	P Pass Pass Pass	alibrated Cp: 11 olerance: - 11	- 244	tem ( C Ti	diagnostics	<u>*</u> + 1	Calcula	



# Tools

# **Design Toolbox**

The Design Toolbox is an interactive spreadsheet tool that provides application-specific design guidelines for capacitive buttons. It is used to configure and validate the CapSense system.

The Design Toolbox:

- Provides general layout guidelines for a CapSense PCB
- Estimates button dimensions based on end-application requirements
- Calculates power consumption based on button dimensions
- Validates layout design

### **Evaluation Kits**

The CY3280-MBR3 Evaluation Kit can be used to quickly evaluate the various features of the CY8CMBR3xxx solution. The kit also functions as an Arduino shield, making it compatible with the various Arduino-based controllers in the market. You can purchase this kit at the Cypress online store.

### Online

In addition to print documentation, there are abundant web resources. The dedicated web page for the CY8CMBR3xxx family has all the current information.

## Training

Free PSoC and CapSense technical training (on-demand, webinars, and workshops) is available online at www.cypress.com/training. The training covers a wide variety of topics and supports different skill levels to assist you in your designs.

## **Technical Support**

For assistance with technical issues, search the Knowledge Base articles and forums at www.cypress.com/support. If you cannot find an answer to your question, create a technical support case or call technical support at 1-800-541-4736.



# Contents

System Overview	
Features Overview	6
CapSense Sensors	6
Sliders	6
Proximity Sensors	6
SmartSense Auto-tuning	6
Liquid Tolerance	6
Noise Immunity	6
Flanking Sensor Suppression (FSS)	6
Touch Feedback	6
General-Purpose Outputs (GPOs)	6
Buzzer Drive	
Register Configurability	7
Communication to Host	7
System Diagnostics	
Ultra-Low Power Consumption	
MPN versus Features Summary	8
Pinouts	
CY8CMBR3116 (16 Sensing Inputs)	9
CY8CMBR3106S	
(16 Sensing Inputs; Sliders Supported)	11
CY8CMBR3108 (8 Sensing Inputs)	
CY8CMBR3110 (10 Sensing Inputs)	
CY8CMBR3102 (2 Sensing Inputs)	
CY8CMBR3002 (2 Sensing Inputs)	
Unused SPO Pin Connection	
Unused SPO Pin Connection for AXRES pins	
Unused GPO Pin Connection	
Device Feature Details	
Automatic Threshold	
Sensitivity Control	
Sensor Auto Reset	
Noise Immunity	
Flanking Sensor Suppression	
General-Purpose Outputs	
LED ON Time	
Toggle	
Buzzer Signal Output	
Host Interrupt	
Latch Status Output	

Analog Voltage Output	. 19
System Diagnostics	.20
Register Configurability	20
Example Application Schematics	.21
Power Supply Information	
Electrical Specifications	
Absolute Maximum Ratings	.24
Operating Temperature	.24
DC Electrical Characteristics	
AC Electrical Specifications	
Memory	
I2C Specifications	
System Specifications	
Power Consumption and Operational States	
Response Time	31
CY8CMBR3xxx Resets	
Host Communication Protocol	
I2C Slave Address	31
I2C Communication Guidelines	
Write Operation	
Setting the Device Data Pointer	
Read Operation	
Layout Guidelines and Best Practices	
Ordering Information	
Ordering Code Definitions	
Packaging Dimensions	
Thermal Impedances	
Solder Reflow Specifications	
Document Conventions	
Units of Measure	
Glossary	
Reference Documents	
Document History Page	
Sales, Solutions, and Legal Information	.43
Worldwide Sales and Design Support	
Products	
PSoC® Solutions	
Cypress Developer Community	
Technical Support	43



# System Overview

A capacitive sensor detects changes in capacitance to determine the presence of a touch or proximity to conductive objects. The capacitive sensor can be a capacitive button that replaces the traditional mechanical buttons, a capacitive slider that replaces mechanical knobs, or a proximity sensor that replaces an infrared sensor in a user interface solution. A typical capacitive user interface system consists of the following:

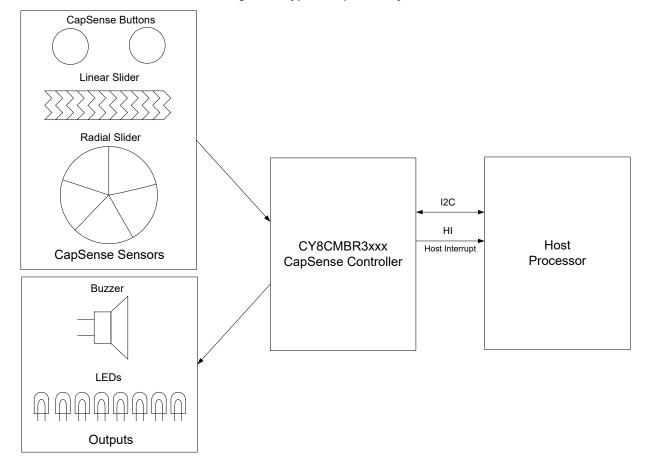
- A capacitive sensor
- An audio-visual output, such as a buzzer or an LED
- A capacitive sensing controller connected to the sensor
- A host processor

The capacitive controller connects the sensor and the output to the host processor through a communication interface, such as an  $I^2C$  or a GPO.

The capacitive user interface system serves as a human-machine interface that takes the user's touch inputs and provides audio-visual feedback through a buzzer or an LED. CY8CMBR3xxx is a family of capacitive sensing controllers, which senses the change in capacitance based on touch or proximity, and controls the user interface system accordingly. The sensing algorithm, built in the controllers, determines the presence of touch and drives the outputs or sends signals to the host processor. This algorithm can distinguish between the signal (based on touch or proximity) and noise, which can be caused by environmental or electrical conditions.

Figure 2 shows a typical user interface system with capacitive buttons connected to a CY8CMBR3xxx CapSense Express controller, which controls the system and also communicates with the host processor through  $I^2C$ .

Traditionally, capacitive sensing controllers require firmware development to perform specific user interface functions and manual system tuning to achieve optimal performance. However, the CY8CMBR3xxx CapSense Express family of controllers does not require any firmware development, accelerating time-to-market. These devices feature SmartSense Auto-tuning, which eliminates the need for manual tuning, providing optimal performance even under extremely noisy conditions.



#### Figure 2. Typical CapSense System



# **Features Overview**

# CapSense Sensors

The CY8CMBR3xxx family of controllers supports up to 16 capacitive sensors. These can be configured as follows:

- Up to 16 CapSense buttons
- Up to two sliders: Configurable as linear or radial sliders
- Up to two proximity sensors that can detect up to 30-cm proximity distance

#### Sliders

- Supports up to two 5-segment sliders
- Configures each slider individually as linear or radial
- Combines both sliders to form one 10-segment slider
- Slider resolution is user-configurable

#### **Proximity Sensors**

- The CY8CMBR3xxx family supports up to two proximity sensors with a detection range of up to 30 cm. These proximity sensors are capable of detecting both proximity and touch events.
- The wake-on-approach feature wakes the devices from a low-power state to Active mode on a proximity event.
- The device also features driven shield, which enhances the proximity sensing range in the presence of metal objects.
- The device supports proximity sensors with C<sub>P</sub> ranging from 8 pF to 45 pF.

### SmartSense Auto-tuning

The CY8CMBR3xxx family features SmartSense Auto-tuning, Cypress's patented CapSense algorithm, which continuously compensates for system and environmental changes during run time. SmartSense Auto-tuning has the following advantages:

- Reduces design effort by eliminating manual tuning
- Adapts to variations in PCB, overlay, paint, and manufacturing that degrade touch-sensing performance
- Eliminates manual tuning in production
- Adapts to changes in the system environment due to noise
- Allows a platform design approach with different overlays, button shapes, and trace lengths

### Liquid Tolerance

The CY8CMBR3xxx family delivers water-tolerant designs that eliminate false touches due to wet conditions, such as water droplets, moisture, mist, steam, or even wet hands. The CapSense controller locks up the user interface in firmware to prevent touch inputs in streaming water. The CY8CMBR3xxx family offers liquid-tolerance to liquids such as water, ketchup, oil, and blood.

Enable the shield electrode through the register map, using EZ-Click, to prevent false touches under wet conditions and enable both the shield electrode and guard sensor to prevent false touches in streaming water conditions. The shield electrode and guard sensor consume a port pin each in the CapSense controller. Refer to the CY8CMBR3xxx CapSense Design Guide for best practices and design guidelines for implementing liquid-tolerant designs.

#### **Noise Immunity**

The CY8CMBR3xxx family features the robust CSD PLUS capacitive sensing algorithm. Additionally, it implements the advanced noise immunity algorithm, EMC, for stable operation in extremely noisy conditions.

The EMC algorithm has higher average power consumption. For low-power applications, where noise conditions are not extreme, you can disable this feature through the  $I^2C$  interface.

### Flanking Sensor Suppression (FSS)

This feature distinguishes between signals from closely spaced buttons, eliminating false touches. It ensures that the system recognizes only the first button touched.

#### **Touch Feedback**

The CY8CMBR3xxx family has pins that you can configure for audio-visual feedback through a buzzer or an LED.

### **General-Purpose Outputs (GPOs)**

The GPOs are high-sink current outputs that can drive most LEDs. The GPO status can be controlled directly by the CapSense sensors so that a sensor 'ON' status automatically turns ON a corresponding LED. Alternatively, GPOs can be controlled by the host through the  $l^2C$  interface.

The GPOs also support advanced features, such as:

- CSx to GPOx Direct Drive: Directly control the GPOs upon button touch or proximity event.
- Pulse width modulation (PWM): Controls LED brightness.
- Toggle: The GPO status is toggled upon every touch event on the button sensors, and proximity event on proximity sensors, to mimic the functionality of the mechanical toggle switch.
- Voltage output: Analog voltage that represents the button status.

### **Buzzer Drive**

The output pins of the CY8CMBR3xxx controllers can be configured for driving a single-input DC Piezo-electric buzzer through a PWM. The PWM frequency and buzzer activation duration are configurable. The buzzer output is activated for a finite amount of time when a finger touch is detected.



# **Register Configurability**

The CY8CMBR3xxx registers may be configured through the  $l^2C$  interface. Device features may be enabled, disabled, or modified by writing appropriate values to the  $l^2C$  configurable register map. This register map also provides various status outputs to indicate the touch/release status and system performance and debug parameters.

You can access the register map of the device through the  $I^2C$  interface by a host controller, such as a microcontroller or the EZ-Click Customizer.

The CY8CMBR3xxx devices feature a safe register map update mechanism to overcome configuration data corruption, which can occur due to power failure during flash writes or any other spurious events. If the configuration data is corrupted during a register map update, the devices reconfigure themselves to the last known valid configuration.

#### **Communication to Host**

The CY8CMBR3xxx family communicates to a host processor through the following methods:

- The I<sup>2</sup>C interface allows the host to configure parameters and receive status information on touch events
- The host interrupt alerts the host when a new touch event occurs. This helps to build effective communication between the host and the CapSense controller. Alternatively, the CPU can poll the device status by reading through I<sup>2</sup>C.
- The GPO provides the ON or OFF sensor status to the host. The GPO ports can also be used to implement analog voltage and DC output (DCO) using an external resistor network.

### **System Diagnostics**

The CY8CMBR3xxx devices are equipped with a system diagnostics feature to detect system-level fault conditions and to

avoid failure of the user interface design. The system diagnostic features also help to monitor system-level parameters to debug the design during development.

The built-in system diagnostics detects the following fault conditions at power-up and helps to monitor the following:

- Improper value of the modulating capacitor (C<sub>MOD</sub>)
- C<sub>P</sub> value out of range
- Sensor shorts

#### **Ultra-Low Power Consumption**

For low-power applications, such as those operated by a battery, select a capacitive sensing controller that has ultra-low average power consumption.

The CY8CMBR3xxx controllers draw an average current of 22  $\mu$ A per sensor at 1.8 V.

The CY8CMBR3xxx family supports two operating modes:

- Active: The sensors are scanned periodically for power optimization.
- Deep Sleep: The sensors are not scanned until a command from the host is received to resume sensor scanning.

In the Active mode, CY8CMBR3xxx family implements additional techniques, such as optimizing the average power consumption and providing a smooth user interface experience without increasing the refresh interval.

In addition to these modes, the device has a wake-on approach feature, which uses proximity sensing to reduce the average power consumption, ensuring power saving when the system is inactive.

Details of all features are documented in Device Feature Details on page 16.



# **MPN versus Features Summary**

The CY8CMBR3xxx family consists of six MPNs, each MPN supporting a different feature set. The following table lists all MPNs and a summary of the features supported by each.

#	Feature	CY8CMBR3116	CY8CMBR3106S	CY8CMBR3110	CY8CMBR3108	CY8CMBR3102	CY8CMBR3002
1	Maximum number of buttons	16	11	10	8	2	2
2	Maximum number of sliders	×	2	×	×	×	×
3	Maximum number of proximity sensors	2	2	2	2	2	×
4	Shield electrode	~	~	~	~	~	×
5	Guard Sensor	~	×	~	~	×	×
6	Wake-on-approach	~	~	~	~	~	×
7	Liquid tolerance	~	×	~	~	~	×
8	Automatic threshold	✓ Configurable	✓ Configurable	✓ Configurable	✓ Configurable	✓ Configurable	V
9	Threshold Override	×	~	×	~	~	×
10	Sensitivity Control	~	~	~	~	~	×
11	Sensor auto-reset	~	~	~	~	~	✔ 20s
12	Median & IIR filter	~	~	~	~	~	~
13	Advanced-Low-Pass Filter	~	×	~	~	~	×
14	Electromagnetic Compatibility (EMC)	~	~	~	~	~	×
15	FSS	~	~	~	V	~	×
16	Maximum number of GPOs/LED drive outputs	8	0	5	4	1	2
17	GPO/LED Sink and Source Drive Support	✔ Configurable	×	✔ Configurable	✔ Configurable	✔ Configurable	Sink
18	LED brightness control	~	×	~	V	v	×
19	LED ON time	~	×	~	~	~	×
20	Toggle	~	×	~	~	~	×
21	Buzzer Signal Output	~	~	~	~	×	×
22	Host interrupt	~	~	~	~	×	×
23	Latch Status Output	~	~	~	~	~	×
24	Analog Voltage Output	~	×	~	~	~	~
25	System diagnostics	~	~	~	~	~	~
26	I <sup>2</sup> C Interface	~	~	~	~	~	×



# **Pinouts**

# CY8CMBR3116 (16 Sensing Inputs)

# Table 1. Pin Diagram and Definitions - CY8CMBR3116

			24-QFN			
Pin #	Pin Name	Туре	Description	If unused	Default Configuration	Pin Diagram
1	CS0/PS0	-	CapSense button/proximity sensor, controls GPO0	Ground/Ground	CS0	20
2	CS1/PS1	-	CapSense button/proximity sensor, controls GPO1	Ground/Ground	CS1	KRES MINBUZ/GPO7 2C SDA CS4 CS5 CS5
3	CS2/GUARD	-	CapSense button/guard sensor, controls GPO2	Ground/Ground	CS2	
4	CS3	-	CapSense button, controls GPO3	Ground	CS3	CS0/PS0 ■ 1
5	CMOD	-	External modulator capacitor. Connect 2.2 nF/5 V/X7R or NPO capacitor	NA	CMOD	CS1/PS1 = 2 17 = CS7 CS2/GUARD = 3 QFN 16 = CS8/GP00 CS3 = 4 (Top View) 15 = CS9/GP01
6	VCC	Power	Internal regulator output. Connect a $0.1-\mu$ F decoupling capacitor if VDD > 1.8 V. If VDD is 1.71 V to 1.89 V, short this pin to VDD.	NA	VCC	$\begin{array}{c} \text{CMOD} = 5 \\ \text{VCC} = 6 \\ \text{CMOD} = 5 \\ \text{CS10/GPO2} \\ \text{CS11/GPO3} \\ \text{CS11/GPO3} \\ \text{CS11/GPO3} \\ \text{CS11/GPO3} \\ \text{CS11/GPO3} \\ \text{CS11/GPO3} \\ \text{CS10/GPO2} \\ \text{CS10/GPO2} \\ \text{CS10/GPO2} \\ \text{CS10/GPO2} \\ \text{CS10/GPO3} \\ C$
7	VDD	Power	Power	NA	VDD	VDD VSS 5/SH/HI 3/GPO5 3/GPO5 2/GPO4
8	VSS	Power	Ground	NA	VSS	5 6 6 6
9	CS15/SH/HI	I/DO	CapSense button/shield electrode/Host Interrupt (SPO1 in the register map)	Refer to Unused SPO Pin Connection on page 15	Ħ	S S S S



### Table 1. Pin Diagram and Definitions - CY8CMBR3116 (continued)

			24-QFN			
Pin #	Pin Name	Туре	Description	If unused	Default Configuration	Pin Diagram
10	CS14/GPO6	I/DO	CapSense button/general purpose output (GPO)	Ground/Refer to Unused GPO Pin Connection on page 15	GPO6	
11	CS13/GPO5	I/DO	CapSense button/GPO Ground/Refer to Unused GPO Pin Connection on page 15 GF		GPO5	
12	CS12/GPO4	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO4	
13	CS11/GPO3	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO3	
14	CS10/GPO2	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO2	
15	CS9/GPO1	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO1	
16	CS8/GPO0	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO0	
17	CS7	-	CapSense button, controls GPO7	Ground	CS7	
18	CS6 <sup>[1]</sup>	1	CapSense button, controls GPO6	Connect to VDD	CS6	
19	CS5	-	CapSense button, controls GPO5	Ground	CS5	
20	CS4	-	CapSense button, controls GPO4	Ground	CS4	
21	I2C SDA	DIO	I2C data	Pull up	I2C SDA	
22	I2C SCL	DIO	I2C clock	Pull up	I2C SCL	
23	HI/BUZ/ GPO7	DO	Host Interrupt/buzzer output/GPO (SPO0 in the register map)	Refer to Unused SPO Pin Connection on page 15	GP07	
24	XRES	XRES	Active Low external reset (an active low pulse on this pin resets the CapSense Controller)	Leave open	XRES	
25	Center Pad <sup>[2]</sup>	E-pad	Connect to VSS for best mechanical, thermal, and electrical performance	Floating, not connected to any other signal	E-pad	

Legend: I = Analog Input, O = Analog Output, DIO = Digital Input/Output, DO = Digital Output, CS = CapSense Button, PS = Proximity Sensor SH = Shield Electrode, BUZ = Buzzer Output, GPO = General Purpose Output, GUARD = Guard Sensor, SPO = Special purpose output.

Notes

2. The center pad on the QFN package should be connected to ground (VSS) for best mechanical, thermal, and electrical performance. If it is not connected to ground, it should be left floating without being connected to any other signal.

<sup>1.</sup> This I/O functions as reset (AXRES) pin during boot-up. Make certain that this pin is not grounded during power-up for the device to boot up properly. After boot-up, this I/O functions as indicated by the pin name.



# CY8CMBR3106S (16 Sensing Inputs; Sliders Supported)

### Table 2. Pin Diagram and Definitions - CY8CMBR3106S

			24-QFN			
Pin #	Pin Name	Туре	Description	If unused	Default Configuration	Pin Diagram
1	CS0/PS0	-	CapSense button/proximity sensor	Ground/Ground	CS0	17
2	CS1/PS1	-	CapSense button/proximity sensor	Ground/Ground	CS1	XRES HI/BUZ I2C SCL I2C SDA CS CS/SH/HI CS5/SH/HI
3	CS2	-	CapSense button	Ground	CS2	
4	CS3	_	CapSense button	Ground	CS3	CS0/PS0 = 1 18 CS15/SLD24
5	CMOD	-	External modulator capacitor. Connect 2.2 nF/5 V/X7R or NPO capacitor	NA	CMOD	CS1/PS1 = 2 17 CS14/SLD23 CS2 = 3 QFN 16 CS13/SLD22 CS3 = 4 (Top View) 15 CS12/SLD21 CMOD = 5 14 CS11/SLD20
6	VCC	Power	Internal regulator output. Connect a 0.1-µF decoupling capacitor if VDD > 1.8 V. If VDD is 1.71 V to 1.89 V, short this pin to VDD.	NA	VCC	
7	VDD	Power	Power	NA	VDD	
8	VSS	Power	Ground	NA	VSS	
9	SLD10	-	Slider1, segment0	Ground	SLD10	
10	SLD11	_	Slider1, segment1	Ground	SLD11	
11	SLD12	-	Slider1, segment2	Ground	SLD12	
12	SLD13	-	Slider1, segment3	Ground	SLD13	
13	SLD14	-	Slider1, segment4	Ground	SLD14	
14	CS11/SLD20	-	CapSense button/Slider2, segment0	Ground/Ground	SLD20	
15	CS12/SLD21	-	CapSense button/Slider2, segment1	Ground/Ground	SLD21	
16	CS13/SLD22	-	CapSense button/Slider2, segment2	Ground/Ground	SLD22	
17	CS14/SLD23	-	CapSense button/Slider2, segment3	Ground/Ground	SLD23	
18	CS15/SLD24 <sup>[3]</sup>	-	CapSense button/Slider2, segment4	Connect to VDD/Connect to VDD	SLD24	
19	CS5/SH/HI	-	CapSense button/shield electrode/host interrupt. (SPO1 in the register map)	Refer to Unused SPO Pin Connection on page 15	CS5	
20	CS4	-	CapSense Button	Ground	CS4	
21	I2C SDA	DIO	I2C Data	Pull up	I2C SDA	
22	I2C SCL	DIO	I2C Clock	Pull up	I2C SCL	
23	HI/BUZ	0	Host interrupt/buzzer output. This pin acts as SPO0 for this device (SPO0 in register map).	Refer to Unused SPO Pin Connection on page 15	HI	
24	XRES	XRES	External reset	Leave open	XRES	
25	Center Pad <sup>[4]</sup>	E-pad	Connect to VSS for best mechanical, thermal and electrical performance	Floating, not connected to any other signal	E-pad	

Legend: I = Analog Input, O = Analog Output, DIO = Digital Input/Output, CS = CapSense Button, PS = Proximity Sensor, SH = Shield Electrode, BUZ = Buzzer Output, SPO = Special Purpose Output.

#### Notes

This I/O functions as reset (AXRES) pin during boot-up. Make certain that this pin is not grounded during power-up for the device to boot up properly. After boot-up, this I/O functions as indicated by the pin name.
 The center pad on the QFN package should be connected to ground (VSS) for best mechanical, thermal, and electrical performance. If it is not connected to ground, it should be left floating without being connected to any other signal.



## CY8CMBR3108 (8 Sensing Inputs)

### Table 3. Pin Diagram and Definitions - CY8CMBR3108

			16-QFN			
Pin #	Pin Name	Туре	Description	lf unused	Default Configuration	Pin Diagram
1	CS0/PS0	_	CapSense button/proximity sensor, controls GPO0	Ground/Ground	CS0	
2	CS1/PS1	_	CapSense button/proximity sensor, controls GPO1	Ground/Ground	CS1	Hilbuz 12C SCL 12C SDA CS3 CS3
3	CMOD	-	External modulator capacitor. Connect 2.2 nF/5 V/X7R or NPO capacitor	NA	CMOD	CS0/PS0 CS0/PS0 CS1/PS1 CS1/PS
4	VCC	Power	Internal regulator output. Connect a 0.1-µF decoupling capacitor if VDD > 1.8 V. If VDD is 1.71 V to 1.89 V, short this pin to VDD	NA	VCC	$\begin{array}{c} \text{CMOD} = 3  (\text{Top View})  10 = \text{CS6/GPO2} \\ \text{VCC} = 4  9 = \text{CS5/GPO1} \\ \hline 0  0  0  0  0 0  0  0  0  0  0 \\ \hline 0  0  0  0  0  0  0 \\ \hline 0  0  0  0  0  0  0  0  0  0$
5	VDDIO	Power	Power for I2C and HI lines	Connect to VDD	VDDIO	SS410 VI
6	VDD	Power	Power	NA	VDD	
7	VSS	Power	Ground	NA	VSS	
8	CS4/GPO0	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO0	
9	CS5/GPO1	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO1	
10	CS6/GPO2	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO2	
11	CS7/GPO3/ SH	I/DO	CapSense button/GPO/shield electrode. (SPO1 in the register map)	Refer to Unused SPO Pin Connection on page 15	GPO3	
12	CS2/GUARD <sup>[5]</sup>	_	CapSense button, controls GPO2/guard sensor	Connect to VDD/Connect to VDD	CS2	
13	CS3	-	CapSense button, controls GPO3	Ground	CS3	
14	I2C SDA	DIO	I2C data	Pull up	I2C SDA	
15	I2C SCL	DIO	I2C clock	Pull up	I2C SCL	
16	HI/BUZ	DO	Host interrupt/buzzer output Supply voltage for <u>bu</u> zzer and pull-up resistor on HI should be equal to VDDIO (SPO0 in the register map).	Refer to Unused SPO Pin Connection on page 15	ΠŢ	
17	Center Pad <sup>[6]</sup>	E-pad	Connect to VSS for best mechanical, thermal and electrical performance	Floating, not connected to any other signal	E-pad	

Legend: I = Analog Input, O = Analog Output, DIO = Digital Input/Output, DO = Digital Output, CS = CapSense Button, PS = Proximity Sensor SH = Shield Electrode, BUZ = Buzzer Output, GPO = General Purpose Output, GUARD = Guard Sensor, SPO = Special Purpose Output.

Notes

This I/O functions as reset (AXRES) pin during boot-up. Make certain that this pin is not grounded during power-up for the device to boot up properly. After boot-up, this I/O functions as indicated by the pin name. The center pad on the QFN package should be connected to ground (VSS) for best mechanical, thermal, and electrical performance. If it is not connected to ground, it should be left floating without being connected to any other signal. 6.

<sup>5.</sup> 



# CY8CMBR3110 (10 Sensing Inputs)

#### Table 4. Pin Diagram and Definitions - CY8CMBR3110

				16-SOIC		
Pin #	Pin Name	Туре	Description	If unused	Default Configuration	Pin Diagram
1	I2C SDA	DIO	I2C data	Pull up	I2C SDA	
2	I2C SCL	DIO	I2C clock	Pull up	I2C SCL	I2C SDA
3	CS0/PS0	-	CapSense button/proximity sensor, controls GPO0	Ground/Ground	CS0	I2C SCL ■ 2 15 ■ CS3 CS0/PS0 ■ 3 14 ■ CS9/GPO4/HI/BUZ
4	CS1/PS1	-	CapSense button/proximity sensor, controls GPO1	Ground/Ground	CS1	CS1/PS1         4         SOIC         13         CS2/GUARD           CMOD         5         12         CS8/GPO3
5	CMOD	_	External modulator capacitor. Connect 2.2 nF/5 V/X7R or NPO capacitor	NA	CMOD	VCC         6         11         CS7/GP02           VDD         7         10         CS6/GP01           VSS         8         9         CS5/GP00
6	VCC	Power	Internal regulator output. Connect a 0.1-µF decoupling capacitor if VDD > 1.8 V. If VDD is 1.71 V to 1.89 V, short this pin to VDD	NA	VCC	
7	VDD	Power	Power	NA	VDD	
8	VSS	Power	Ground	NA	VSS	
9	CS5/GPO0	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO0	
10	CS6/GPO1	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO1	
11	CS7/GPO2	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO2	
12	CS8/GPO3	I/DO	CapSense button/GPO	Ground/Refer to Unused GPO Pin Connection on page 15	GPO3	
13	CS2/GUARD	_	CapSense button, controls GPO2/guard sensor	Ground/Ground	CS2	
14	CS9/GPO4/ <del>H</del> I/ BUZ <sup>[7]</sup>	I/DO	CapSense button/GPO/host interrupt/buzzer output. (SPO1 in the register map)	Refer Unused SPO Pin Connection for AXRES pins on page 15	GPO4	
15	CS3	_	CapSense button, controls GPO3	Ground	CS3	
16	CS4/SH	I/O	CapSense button, controls GPO4/shield electrode (SPO0 in the register map).	Refer to Unused SPO Pin Connection on page 15	CS4	

Legend: I = Analog Input, O = Analog Output, DIO = Digital Input/Output, DO = Digital Output, CS = CapSense Button, PS = Proximity Sensor SH = Shield Electrode, BUZ = Buzzer Output, GPO = General Purpose Output, GUARD = Guard Sensor, SPO = Special Purpose Output.

Note

7. This I/O functions as reset (AXRES) pin during boot-up. Make certain that this pin is not grounded during power-up for the device to boot up properly. After boot-up, this I/O functions as indicated by the pin name.



# CY8CMBR3102 (2 Sensing Inputs)

### Table 5. Pin Diagram and Definitions - CY8CMBR3102

				8-SOIC		
Pin #	Pin Name	Туре	Description	If unused	Default Configuration	Pin Diagram
1	I2C SCL	DIO	I2C clock	Pull up	I2C SCL	
2	CMOD	_	External modulator capacitor. Connect 2.2 nF/5 V/X7R or NPO capacitor	NA	CMOD	
3	VCC	Power	Internal regulator output. Connect a 0.1-µF decoupling capacitor if VDD > 1.8 V. If VDD is 1.71 V to 1.89 V, short this pin to VDD.	NA	VCC	$\begin{array}{c c} CMOD & \square & 2 \\ VCC & \square & 3 \\ VDD & \square & 4 \\ \end{array} \begin{array}{c} 7 \\ 6 \\ - \\ 7 \\ - \\ 0 \\ - \\$
4	VDD	Power	Power	NA	VDD	
5	VSS	Power	Ground	NA	VSS	
6	CS1/PS1/ GPO0/SH	I/DO/O		Refer to Unused SPO Pin Connection on page 15	GPO0	
7	CS0/PS0 <sup>[8]</sup>	-	CapSense button/proximity sensor, controls GPO0	Connect to VDD/ Connect to VDD	CS0	
8	I2C SDA	DIO	I2C data	Pull up	I2C SDA	

Legend: I = Analog Input, O = Analog Output, DIO = Digital Input/Output, DO = Digital Output, CS = CapSense Button, PS = Proximity Sensor, SH = Shield Electrode, GPO = General Purpose Output, SPO = Special Purpose Output.

### CY8CMBR3002 (2 Sensing Inputs)

#### Table 6. Pin Diagram and Definitions - CY8CMBR3002

			8-S	OIC	
Pin #	Pin Name	Туре	Description	If unused	Pin Diagram
1	GPO1	DO	Active-low GPO with open-drain-low drive mode	Ground	
2	CMOD	I/O	External modulator capacitor. Connect 2.2 nF/5 V/X7R or NPO capacitor	NA	GPO1 = 1 8 = GPO0 CMOD = 2 7 = CS0
3	VCC	Power	Internal regulator output. Connect a 0.1-µF decoupling capacitor if VDD > 1.8 V. If VDD is 1.71 V to 1.89 V, short this pin to VDD.	NA	$\begin{array}{c c} CMOD & \square & 2 \\ VCC & \square & 3 \end{array} \xrightarrow{7} \square & CSU \\ CS1 \\ VDD & \square & 4 \end{array} \xrightarrow{7} \square & CSU \\ CS1 \\ VSS \end{array}$
4	VDD	Power	Power	NA	
5	VSS	Power	Ground	NA	
6	CS1	-	CapSense button, controls GPO1	Ground	
7	CS0 <sup>[8]</sup>	-	CapSense button, controls GPO0	Connect to VDD	
8	GPO0	DO	Active-low GPO with open-drain-low drive mode	Ground	

Legend: I = Analog Input, DO = Digital Output, CS = CapSense Button, GPO = General Purpose Output

#### Note

8. This I/O functions as reset (AXRES) pin during boot-up. Make certain that this pin is not grounded during power-up for the device to boot up properly. After boot-up, this I/O functions as indicated by the pin name.



# **Unused SPO Pin Connection**

The following table lists the recommended pin connections for different configurations of SPO pins if an SPO pin is unused. Note that this table is not applicable to SPO pins which act as AXRES during boot up.

### Table 7. Unused SPO Pin Connection

SPO Pin Configuration	Recommended pin connection if unused
CS	Connect to Ground
HI	Leave Open
SH	Leave Open
GPO	Refer to "Unused GPO Pin Connection" Table
BUZ	Leave Open
Disabled	Leave Open

# Unused SPO Pin Connection for AXRES pins

Unused SPO pins which act as AXRES during boot up should be left open and should be disabled through the I2C configurable register map (using Ez-Click or any other configuration tool mentioned in section "Configuring CY8CMBR3xxx" of CY8CMBR3xxx CapSense Design Guide).

# **Unused GPO Pin Connection**

The following table lists the recommended pin connections for different drive modes of GPO pins if a GPO pin is unused. Note that this table is not applicable to GPO pins which act as AXRES during boot up.

#### Table 8. Unused GPO Pin Connection

GPO drive mode	Recommended pin connection if unused
Open Drain Low	Connect to Ground
Strong	Leave Open



# **Device Feature Details**

#### Table 9. Device Feature Benefits

Feature	Benefits
Automatic Threshold	Automatically tunes all the threshold parameters of the sensors for different noise settings
Sensitivity Control	Maintains optimal button performance for different overlay and noise conditions
Sensor Auto Reset	Recalibrates the sensor when a stuck-sensor (fault) condition occurs, and avoids invalid sensor output status to host
Noise Immunity	Provides immunity against external noise and the ability to detect touches without false trigger in noisy environments
Flanking Sensor	Avoids multiple button triggers in a
Suppression (FSS) Host Controlled GPOs	design with closely spaced buttons GPO pins, which can be controlled by the host processor through I <sup>2</sup> C
LED On time	GPO output status stays ON for a set duration after the touch is released to provide better visual feedback to the user
Toggle	Sensor output status toggles on every sensor activation to mimic the mechanical toggle button functionality
Buzzer Signal Output	Provides audio feedback on button touch
Host Interrupt	Provides interrupt to host when there is a change in sensor status
Latch Status Output	Latches the sensor status changes in the register until the host reads the activated sensor status; this ensures that the sensor status is always read by the host even if the host is late to service the host interrupt signal from CY8CMBR3xxx
Analog Voltage Output	Indicates the button status through voltage levels
System Diagnostics	Supports production testing and debugging
Low-Power Sleep Mode and Deep Sleep Mode	Reduces power consumption

### **Automatic Threshold**

- Dynamically sets all threshold parameters for button sensors, depending on the noise in the environment.
- Can be enabled or disabled through the register map.
- Applicable only to button sensors.
- Mutually exclusive from the EMC feature. If EMC is enabled, automatic threshold is automatically disabled.
- Allows overriding of calculated thresholds with particular values specified through the register map. Refer to the CY8CMBR3xxx CapSense Design Guide for more details.

#### **Sensitivity Control**

This feature allows specification of the minimum change in sensor capacitance that can trigger a sensor state change (OFF to ON or vice-versa).

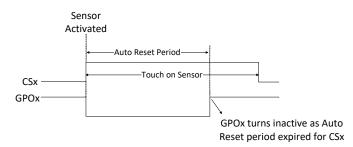
- Sensitivity can be specified individually for each CapSense button and slider.
- Sensitivity can be specified as one of the four available values: 0.1 pF, 0.2 pF, 0.3 pF, and 0.4 pF.
- Higher sensitivity values can be used for thick overlays or small button diameters.
- Lower sensitivity values should be used for large buttons or thin overlays to minimize power consumption.

### **Sensor Auto Reset**

This feature resets the CapSense sensors to the OFF state after a specific time period, even though they continue to be activated.

- Resets the sensor baseline to the current raw count after a specific time period, even though the sensors continue to be activated.
- Prevents a stuck sensor when a metal object is placed close to that sensor.
- The Auto Reset period can be set to 5 or 20 seconds and can be configured through two global settings provided in the register map:
  - Global setting for all proximity sensors
  - □ Global setting for all CapSense buttons and slider segments
- The guard sensor does not undergo Auto Reset.

# Figure 3. Example of Button Auto Reset on GPO0 (DC Active Low Output)





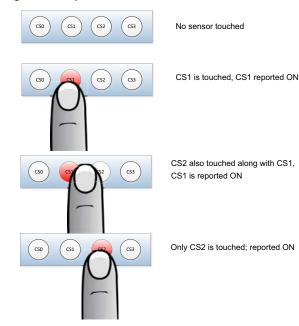
### **Noise Immunity**

- The CY8CMBR3xxx family features the robust CSD PLUS capacitive sensing algorithm.
- Uses pseudo-random sequence (PRS) clock source to minimize electromagnetic interference.
- Provides advanced noise immunity algorithm, that is, electromagnetic compatibility (EMC), for superior noise immunity against external radiated and conducted noise
  - EMC algorithm has higher average power consumption. For low-power applications, where noise conditions are not extreme, this feature can be disabled using the EZ-Click tool.
- Provides median and IIR filters for button and slider sensors.
- Provides an Advanced-Low-Pass (ALP) filter for proximity sensors.

### Flanking Sensor Suppression

- Distinguishes between signals from closely spaced buttons, eliminating false touches.
- Can be enabled or disabled individually on each CapSense button.
- On touch detection by two or more sensors on which FSS is enabled, only the first touched sensor reports active status.
- Allows only one button at a time to be in the Touch state.
- Supported only on CapSense buttons.

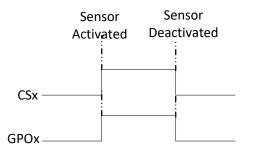
#### Figure 4. Reported Sensor Status with FSS Enabled



**General-Purpose Outputs** 

- Supports up to eight GPOs, multiplexed with sensor inputs or other functionality, depending on the part number.
- Provides GPO status control. GPOs can be configured to be controlled by the sensor input or the host through the I<sup>2</sup>C interface.
- Allows for configurable Active LOW or Active HIGH logic output. The Active LOW logic output can be configured to directly drive LEDs in the current sink mode. The Active HIGH logic output can be configured to interface the GPOs with the host and other circuits.
- The GPOx status will not be retained in the Deep Sleep mode. The GPOx output state will be reset to default during deep sleep and upon wake-up from deep sleep.

#### Figure 5. CSx Controls GPOx (Active HIGH Logic)



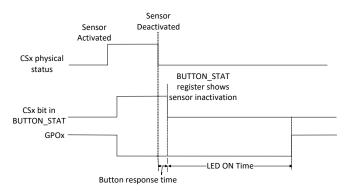
- Supports two drive modes:
  - Open-drain drive mode (HIGH-Z and GND) for analog voltage outputs and LED direct drive
  - Strong drive mode (V<sub>DD</sub> and GND) to interface with the host and other circuits
- Supports PWM on GPOs for LED brightness control. Two different duty cycles can be configured for Sensor Touch and No Touch states (Active and Inactive state duty cycles). When the GPO is host-controlled, and if the PWM control is enabled for the GPO, the same Touch and No Touch duty cycles will be used for the On and Off states of the host-controlled GPO.
- When the proximity sensor is enabled, the proximity event controls the respective GPOs. A touch event on a proximity sensor is indicated only through the I<sup>2</sup>C register map.
- Sensor fault conditions are indicated with the pulse signal on the respective GPOs at power-up by system diagnostics.



# **LED ON Time**

Keeps the GPO status ON for a particular period of time after the falling edge of a sensor, for better visual indication through LEDs

#### Figure 6. CSx Controls GPOx with LED ON Time Enabled

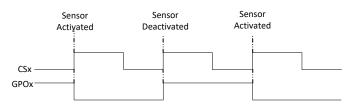


- Can be enabled only when the GPO is directly controlled by a CapSense sensor
- Can be enabled or disabled on each sensor and the ON Time duration can be configured from 0 to 2 seconds in 20-ms increments
- Can be enabled in all configurations of GPOs except the Toggle mode
- Not applicable when the sensor status is turned off by Sensor Auto Reset

### Toggle

The controller can toggle the GPO state at every rising edge of a sensor activation event to mimic the functionality of a mechanical toggle switch (a touch event for a button sensor and a proximity event for proximity sensors activates a sensor).

#### Figure 7. CSx Controls GPOx with the Toggle Enabled

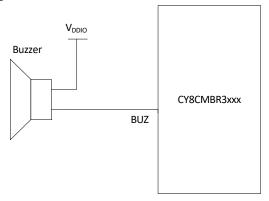


- Can be enabled only when the GPO is directly controlled by a capacitive sensor.
- Can be enabled or disabled individually on each capacitive sensor.
- Can be enabled in all configurations of GPOs—that is, Active LOW and Active HIGH DC output, PWM output, open-drain, and strong drive modes.

### **Buzzer Signal Output**

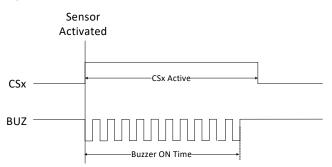
- Produces a PWM signal to drive a Piezo-Buzzer that generates audio feedback when a touch is detected on a CapSense button or a guard sensor.
- Supports buzzer connection, as shown in the following figure.

#### Figure 8. Buzzer Connection<sup>[9]</sup>



- PWM frequency is configurable: The buzzer frequency is configurable to meet different Piezo-Buzzer drive requirements and to provide different tones. The buzzer frequency may be configured either by using the EZ-Click tool or by writing to the corresponding control register. Refer to System Specifications on page 27 for the supported buzzer frequencies.
- Generates PWM output for a fixed duration (ON time) when a touch is detected. The ON time is configurable through EZ-Click, from 100 ms to 12.7 s, in steps of 100 ms,
- Buzzer signal output and EMC (refer to the CY8CMBR3xxx Registers TRM) are mutually exclusive features. These must not be enabled simultaneously.

#### Figure 9. Buzzer Activation on a Touch Event



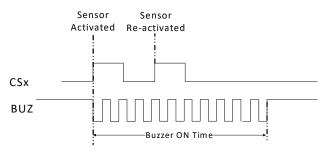
The buzzer output does not restart if multiple trigger events occur before the Buzzer ON Time elapses.

#### Note

9. Buzzer must be connected between V<sub>DDIO</sub> and the BUZ pin. If V<sub>DDIO</sub> is not available on the device, connect the buzzer to V<sub>DD</sub> instead of V<sub>DDIO</sub>.



#### Figure 10. Buzzer Operation with Consecutive Touches



If the buzzer is not currently active, the buzzer output starts on each trigger event.

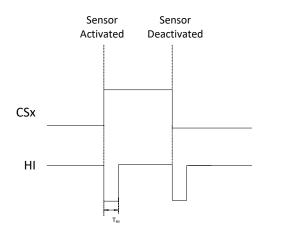
- When the buzzer is enabled, the buzzer output toggles between a Logic HIGH state and a Logic LOW state, to drive the buzzer when active. When the buzzer is inactive, the buzzer output maintains a Logic HIGH state.
- The buzzer ON Time has a range of (1 to 127) × 100 ms.

#### Host Interrupt

This feature generates a pulse signal on any change in the CapSense sensors' status.

- The host interrupt is an active LOW pulse signal generated on the HI pin during any change in the sensor status or slider position.
- The duration of the active LOW host interrupt pulse is T<sub>HI</sub> (refer to System Specifications on page 27).
- The minimum time between two H pulses is equal to one refresh interval.

# Figure 11. Host Interrupt Line with CSx Buttons Touched Separately



- The host interrupt pin has the open-drain low-drive mode.
- This pin is powered by V<sub>DDIO</sub> in CY8CMBR3108. This allows communication with a host processor at voltage levels lower than the chip V<sub>DD</sub>.
- Only one pin can be configured as the host interrupt on devices that have a host interrupt functionality on multiple pins.

### Latch Status Output

- Allows to read both current status (CS) and latch status (LS) to avoid missing button touches.
- CS and LS can be read through registers, BUTTON\_STAT, and LATCHED\_BUTTON\_STAT respectively.
- Table 10 explains the various combinations of CS and LS.

#### Table 10. Latch Status Read

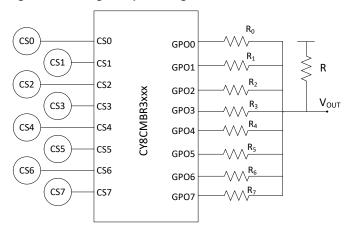
CS	LS	Description
0	0	CSx is not touched during the current I <sup>2</sup> C read Host has already acknowledged any previous CSx touch in the previous I <sup>2</sup> C read
0	1	CSx was touched before the current I <sup>2</sup> C read This CSx touch was missed by the host

### **Analog Voltage Output**

Some of the applications use analog voltage as an effective method to indicate the sensor status to the host controller. A simple external resistor network can be used with GPOs of CY8CMBR3xxx to generate analog voltage output upon touch detection for such applications.

The CY8CMBR3xxx GPOs support the open-drain low-drive mode. In this mode, the sensor "touch" state is indicated by a logic LOW signal on the GPO and a "no touch" state is indicated by the HIGH-Z signal. With the external resistor shown in Figure 12, when a sensor is touched, the respective GPO is driven to a logic LOW signal. This forms a simple voltage divider and produces a voltage output. All the other GPOs are in HIGH-Z states because their respective sensors are in the "no touch" state.

#### Figure 12. Voltage Output Using GPO and Resistor Network



The output analog voltage can be calculated based on the following equation:

$$Vout = \frac{VDD \times Rn}{R + Rn}$$

Here, Rn represents the series resistor value of any given GPO.

**Note** If more than one button is activated at the same time, the Rn becomes equivalent (parallel) to all Rn resistors.



- For the circuit represented in Figure 12 to work, GPOs should be configured in the Active LOW logic, open-drain drive mode. PWM must be disabled and the CSx-to-GPOx direct drive must be enabled (that is, GPOs must be configured as sensor-controlled).
- The FSS feature can be enabled so only one button is reported ON at a time.

### System Diagnostics

System Diagnostics is a BIST feature that tests for faulty sensor, shield, or CMOD conditions at device resets.

- If any sensor fails these tests, a 50-ms pulse is sent out on the corresponding GPO (that is, the pulse is observed on GPOx if CSx fails the test), and the sensor is disabled.
- If the shield fails the tests, a 50-ms pulse is sent out on all GPOs and all the sensors are disabled.
- If CMOD fails the tests, a 50-ms pulse is sent out on all GPOs and all the sensors are disabled.
- System Diagnostics failure pulses are sent within device boot-up time.
- The System Diagnostics status is also updated in the register map. Therefore, the host can also read test results through the I<sup>2</sup>C interface.

#### Sensor C<sub>P</sub> > 45 pF

If the parasitic capacitance of a sensor is more than 45 pF, the sensor is disabled.

#### Improper value of CMOD

If the value of CMOD is less than 1 nF or greater than 4 nF, all sensors are disabled (the recommended value of CMOD is 2.2 nF).

#### Sensor shorts

System Diagnostics also checks for the following errors:

- Sensor shorted to V<sub>ss</sub><sup>[10]</sup>
- Sensor shorted to V<sub>DD</sub>
- Sensor shorted to another sensor
- Sensor shorted to shield

# **Register Configurability**

The CY8CMBR3xxx family features an  $I^2C$  configurable register map. The CY8CMBR3xxx registers are divided into three categories, as Table 11 shows.

#### Table 11. CY8CMBR3xxx Registers

Register Category	Register Map Address range	Description
Configu- ration Registers	0x00-0x7E	These registers contain the config- uration data for the CY8CMBR3xxx controllers. A host can write into these registers and save the data to non-volatile memory by writing to CTRL_CMD command register. Note that the new configuration takes effect only after the configu- ration is saved to non-volatile memory and the device is reset (see CY8CMBR3xxx Resets on page 31).
Command Registers		These registers accept commands from host. Any command written to these register is executed within $T_{12C\_LATENCY\_MAX}$ from the $I^2C$ acknowledgement of the command.
Status Registers	0x88-0xFB	These are read only registers and indicate the status of command execution, system diagnostics and sensor data.

The CY8CMBR3xxx devices feature a safe register map update mechanism to overcome configuration data corruption, which can occur due to power failure during execution of "Save" command or any other spurious events.

If the configuration data is corrupted when the device is saving data, on the next reset, the devices reconfigure themselves to the last known valid configuration. If there is no valid configuration saved by user, the devices load the factory default configuration as specified in Register TRM.

10. Sensor shorts to Vss are detected for all pins other than the pin, which is AXRES also for a given package.

Note



# **Example Application Schematics**

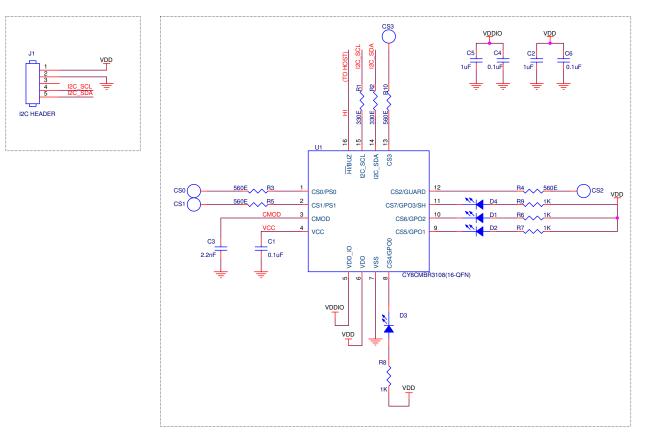


Figure 13. Example Schematics Demonstrating Four Buttons and Four GPOs

In Figure 13<sup>[11, 12]</sup>, the CY8CMBR3108 device is configured in the following manner:

- CS0–CS3: CapSense buttons
  - All CapSense pins must have a 560-ohm series resistance (placed close to the chip) for improved noise immunity.
- GPO0–GPO3: To external LEDs
  - LEDs are connected in sinking mode because the CY8MBR3xxx devices have high sink current capability.
  - $\square$  Series resistances are connected to limit the GPO current to be with  $I_{\rm IL}$  limits.
- CMOD pin: 2.2 nF to ground
- VCC pin: 0.1 µF to ground

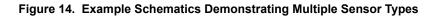
- VDD pin: To external supply voltage
  - $\square$  1-µF and 0.1-µF decoupling capacitors connected to VDD
- VDDIO pin: To supply voltage, which is ≤ VDD
   □ VDDIO powers I<sup>2</sup>C and HI lines.
   □ 1-µF and 0.1-µF decoupling capacitors connected to VDDIO.
- I2C SCL and I2C SDA pins: 330 ohms to the I<sup>2</sup>C header
- □ For I<sup>2</sup>C communication: It is assumed that the I<sup>2</sup>C line pull-up resistors are present on the host side outside the I<sup>2</sup>C header.
- HI pin: To host
- To prompt the host to initiate an I<sup>2</sup>C transaction for reading the changed sensor status.

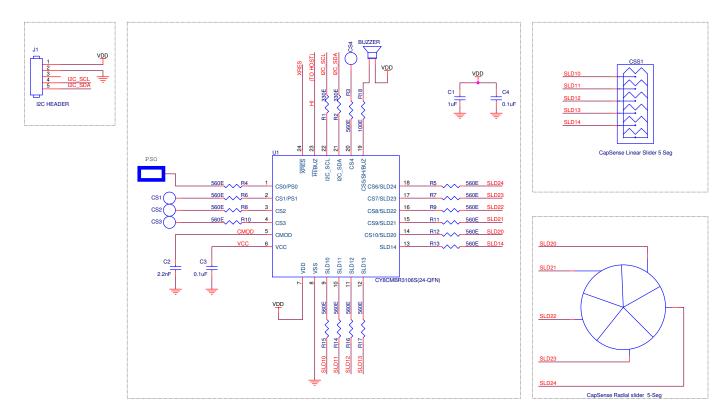
Notes

12. Proper ground layout is important for better SNR performance. Refer to the CY8CMBR3xxx CapSense Design Guide and Getting started with CapSense guide for all layout guidelines.

<sup>11.</sup> VCC should be connected to VDD for 1.71 V  $\leq$  VDD  $\leq$  1.89 V.







In Figure  $14^{[13, 15]}$ , the CY8CMBR3106S device is configured in the following manner:

- PS0: CapSense proximity sensor
- CS1–CS4: CapSense buttons<sup>[14]</sup>
- CMOD pin: 2.2 nF to ground
- VCC pin: 0.1 uF to ground
- VDD pin: To external supply voltage □ 1-µF and 0.1-µF decoupling capacitors connected to VDD
- SLD10-SLD14: CapSense linear slider segments
- SLD20-SLD24: CapSense radial slider segments
- BUZ: To buzzer

□ AC buzzer (1-pin).

Buzzer second pin to ground.

- I2C\_SCL and I2C\_SDA pins: 330 ohm to the I<sup>2</sup>C header. It is assumed that the I<sup>2</sup>C line pull-up resistors are present on the host side outside the I<sup>2</sup>C header.
   For I2C communication.
- HI pin: To host
  - To prompt the host to initiate an I<sup>2</sup>C transaction for reading the changed sensor status.
- XRES pin: Floating □ For external reset.

#### Notes

- 13. VCC should be shorted to VDD for 1.71 V  $\leq$  VDD  $\leq$  1.89 V.
- 14. All CapSense pins have 560-ohm series resistance (placed close to the chip) for improved noise immunity.

15. Proper ground layout is important for better SNR performance. Refer to the CY8CMBR3xxx CapSense Design Guide and Getting started with CapSense guide for all layout guidelines.



# Power Supply Information

The CY8CMBR3xxx family of controllers contains three supply domains: V<sub>DD</sub>, V<sub>CC</sub>, and V<sub>DDIO</sub>.

- V<sub>DD</sub>: This is the primary supply to the chip and can be powered from 1.8 V ± 5% (Externally regulated mode) or 1.8 to 5.5 V (Internally regulated mode). The CapSense controller is powered by the V<sub>DD</sub> supply, and all the I/O signal levels (except  $I^2$ C lines,  $\overline{HI}$ , and  $\overline{XRES}$ ) are referenced with respect to the V<sub>DD</sub> supply. For packages and MPNs that do not have VDDIO, the I<sup>2</sup>C SDA, I<sup>2</sup>C SCL, HI, and XRES signal levels are also referenced with respect to the V<sub>DD</sub> supply.
- V<sub>DDIO</sub>: This is the supply input for I<sup>2</sup>C SDA, I<sup>2</sup>C SCL, HI, and XRES lines. The signal levels of these I/Os are referenced with respect to  $V_{DDIO}$ . The  $V_{DDIO}$  supply can be as low as 1.71 V and as high as the voltage of the  $V_{DD}$  supply. The  $V_{DDIO}$  should not be powered at a voltage higher than that of the V<sub>DD</sub> supply. The V<sub>DDIO</sub> is available only on select packages. For a package that does not have  $V_{DDIO}$ , the I<sup>2</sup>C SDA, I<sup>2</sup>C SCL, HI, and XRES signal levels are referenced with respect to the V<sub>DD</sub> supply.
- V<sub>CC</sub>: This is the internal regulator output, which powers the core and capacitive sensing circuits. A 0.1-µF, 5-V ceramic capacitor should be connected close to the V<sub>CC</sub> pin for better performance.
- Power sequencing: The CY8CMBR3xxx device does not require any power supply sequencing for the VDD and VDDIO supplies. Either of these supplies can ramp earlier or later than the other. The only requirement is that VDDIO should not be greater than VDD.

1.8-V externally regulated operation: When V<sub>DD</sub> is powered with a 1.8 V  $\pm$ 5% supply, the V<sub>CC</sub> and V<sub>DD</sub> pins should be shorted externally and the SUPPLY\_LOW\_POWER bit in the DEVICE\_CFG3 register should be set to 1 through the I<sup>2</sup>C interface (refer to the CY8CMBR3xxx Registers TRM for details on the register). When the VCC and VDD pins are shorted, this bypasses the internal voltage regulator. Under this condition, make certain that VDD does not exceed 1.89 V.

Note: If EZ-Click is used to configure the device, it automatically takes care of the required register settings based on the voltage settings selected in EZ-Click.

The CY8CMBR3xxx family of controllers is factory-configured for 1.8-V to 5.5-V operation. To configure a factory-configured device for 1.8-V externally regulated operation, you can use the following procedure:

- Short V<sub>DD</sub> and V<sub>CC</sub>.
- Power the device at 1.8 V (note that regardless of the value of the SUPPLY\_LOW\_POWER bit, the device can be powered at 1.8 V for configuring the device; only CapSense operation is not guaranteed if the SUPPLY\_LOW\_POWER bit is not properly configured)
- Use EZ-Click to configure the device for 1.8-V operation.
- Save and reset the device.
- Ground consideration: Both the V<sub>SS</sub> pin and the metal pad (E-pad) of the device should be connected to board ground.

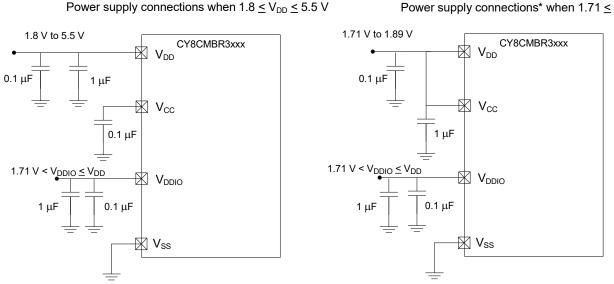


Figure 15. Power Supply Connections for CY8CMBR3xxx CapSense Controllers<sup>[16]</sup>

Power supply connections<sup>\*</sup> when  $1.71 \le V_{DD} \le 1.89 \text{ V}$ 

\*SUPPLY\_LOW\_POWER bit in DEVICE\_CFG3 register should be set to 1 to operate device at 1.8V ( $\pm$ 5%)

Note

16. Proper ground layout is important for best performance. Refer to the layout guidelines mentioned in the CY8CMBR3xxx CapSense Design Guide and Getting started with CapSense guide.



# **Electrical Specifications**

### **Absolute Maximum Ratings**

# Table 12. Absolute Maximum Ratings<sup>[17]</sup>

Parameter	Description	Conditions	Min	Тур	Max	Units
V <sub>DD_MAX</sub>	Max voltage on the $V_{\text{DD}}$ pin relative to $V_{\text{SS}}$	–40 °C to +85 °C T <sub>A</sub> , absolute maximum	-0.5	_	6	V
V <sub>DDIO_MAX</sub>	Max voltage on the $V_{\mbox{\scriptsize DDIO}}$ pin relative to $V_{\mbox{\scriptsize SS}}$	–40 °C to +85 °C T <sub>A</sub> , absolute maximum	0.5	_	6	V
V <sub>CC_MAX</sub>	Max voltage on the VCC pin relative to $V_{SS}$	Absolute maximum	-0.5	_	1.89	V
V <sub>IO</sub>	DC input voltage relative to $V_{SS}$ on I/O	–40 °C to +85 °C T <sub>A</sub> , absolute maximum	-0.5	-	V <sub>DD</sub> +0.5	V
ESD_HBM	Electrostatic discharge, human body model	Human body model ESD.	2200	_	-	V
	Electrostatic discharge, charged device model	Charged device model ESD	500	-	_	V
I <sub>LU</sub>	Latch-up current limits	Maximum/minimum current to any input or output, pin-to-pin or pin-to-supply	-140	_	140	mA
I <sub>IO</sub>	Current per GPIO		_	_	25	mA

# Operating Temperature

### Table 13. Operating Temperature

Parameter	Description	Conditions	Min	Тур	Max	Units
т <sub>о</sub>	L'Uperation temperature	Ambient temperature inside system enclosure	-40	25	85	°C
Τ <sub>J</sub>	Junction temperature		-40	-	100	°C

### **DC Electrical Characteristics**

#### DC Chip-Level Specifications

The specifications in Table 14 are valid under these conditions: –40 °C  $\leq$  T<sub>A</sub>  $\leq$  85 °C. Typical values are specified at T<sub>A</sub> = 25 °C, V<sub>DD</sub> = 3.3 V, and are for design guidance only.

#### Table 14. DC Chip-Level Specifications

Parameter	Description	Conditions/Details	Min	Тур	Max	Units
		$V_{CC}$ shorted to $V_{DD}$	1.71	1.8	1.89	V
V <sub>DD</sub>	Chip supply voltage	$V_{CC}$ not shorted to $V_{DD}.$ $V_{CC}$ connected to 0.1 $\mu F$ decoupling capacitor	1.8	Ι	5.5	V
V <sub>DDIO</sub>	Supply voltage I/O	1.71 V < V <sub>DD</sub> < 1.89 V	1.71	Ι	$V_{DD}$	V
VOIDO	oupply voltage #0	1.8 V < V <sub>DD</sub> < 5.5 V	1.71	-	$V_{DD}$	V
V	Maximum allowed ripple on power supply, DC to 10 MHz	+25 °C T <sub>A</sub> , V <sub>DD</sub> > 2 V, sensitivity $\ge$ 0.1 pF	_	_	±50	mV
V <sub>DD_RIPPLE</sub>		+25 °C T <sub>A,</sub> V <sub>DD &gt;</sub> 1.75 V, C <sub>P</sub> < 20 pF, sensitivity = 0.4 pF	_	-	±25	mV
C <sub>EFC</sub>	External regulator voltage bypass (capacitor to be connected to the V <sub>CC</sub> pin)	X5R ceramic ±10% or better	_	0.1	_	μF
C <sub>EXC</sub>	Power supply decoupling capacitor on V <sub>DD</sub>	X5R ceramic or better	_	1	_	μF

Note

<sup>17.</sup> Usage above the absolute maximum conditions listed in Table 12 may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods of time may affect device reliability. The maximum storage temperature is 150 °C in compliance with JEDEC Standard JESD22-A103, High Temperature Storage Life. When used below absolute maximum conditions, but above normal operating conditions, the device may not operate to specification.



### XRES DC Specifications

### Table 15. XRES DC Specifications

Parameter	Description	Conditions/Details	Min	Тур	Max	Units
V <sub>IH_XRES</sub>	Input voltage high threshold on XRES pin	CMOS input	0.7*V <sub>DD</sub>	-	-	V
V <sub>IL_XRES</sub>	Input voltage low threshold on XRES pin	CMOS input	-	-	0.3*V <sub>DD</sub>	V
C <sub>IN_XRES</sub>	Input capacitance on XRES pin		-	-	7	pF
V	Input voltage hysteresis on XRES pin	V <sub>DD</sub> ≤ 4.5 V	-	0.05*V <sub>DD</sub>	-	mV
V <sub>HYSXRES</sub>	HYSXRES Input voltage hysteresis on Artes pin	V <sub>DD</sub> > 4.5 V	200	-	-	mV
R <sub>PULLUP</sub>	Pull-up resistor		3.5	5.6	8.5	kΩ

### DC I/O Port Specifications

The specifications in Table 16 are valid at –40 °C  $\leq$  T<sub>A</sub>  $\leq$  +85 °C. Typical parameters are specified at T<sub>A</sub> = 25 °C and are for design guidance only.

# Table 16. DC I/O Port Specifications

Parameter	Description	Conditions	Min	Тур	Max	Units
V <sub>OH</sub>	Output voltage HIGH level	I <sub>OH</sub> = –4 mA at 3 V V <sub>DD</sub>	V <sub>DD</sub> -0.6	Ι	Ι	V
¥ OH		I <sub>OH</sub> = –1 mA at 1.8 V V <sub>DD</sub>	V <sub>DD</sub> -0.5	_	_	V
N.	Output voltage LOW level	I <sub>OL</sub> = 4 mA at 1.8 V V <sub>DD</sub>	_	-	0.6	V
V <sub>OL</sub>		I <sub>OL</sub> = 10 mA at 3 V V <sub>DD</sub>	-	-	0.6	V
C <sub>PIN</sub>	Pin capacitance	All V <sub>DD</sub> , all packages, all I/Os	-	3	7	pF
I <sub>TOT_GPIO</sub>	Maximum total sink chip current		-	_	85	mA

### **AC Electrical Specifications**

### Table 17. AC Chip-Level Specifications

Parameter	Description	Conditions	Min	Тур	Мах	Units
ISR POWER UP	Power supply slew rate at power-up and power-down	–40 °C ≤ TA ≤ 85 °C, all V <sub>DD</sub>	1	-	67	V/ms

XRES AC Specifications

### Table 18. XRES AC Specifications

Parameter	Description	Conditions/Details	Min	Тур	Мах	Units
T <sub>XRES</sub>	External reset pulse width	–40 °C ≤ T <sub>A</sub> ≤ 85 °C, all V <sub>DD</sub>	5	-	-	μs



# Memory

### Table 19. Flash Specifications

Parameter	Description	Min	Тур	Max	Units	<b>Details/Conditions</b>
F <sub>END</sub> <sup>[19]</sup>	Flash endurance	100 K	-	-	cycles	
F <sub>RET</sub> <sup>[19]</sup>	Flash retention. $T_A \le 55$ °C, 100 K P/E cycles	20	-	-	years	

# I<sup>2</sup>C Specifications

# Table 20. I<sup>2</sup>C Specifications

Parameter	Description	Min	Тур	Max	Units	Conditions
FSCLI2C_FM	I <sup>2</sup> C SCL clock frequency	0	١	400	kHz	
THDSTAI2C_FM	Hold time (repeated) START condition; after this period, the first clock pulse is generated	0.6	Ι	_	μs	
TSUSTAI2C_FM	Setup time for a repeated START condition	0.6		_	μs	
TLOWI2C_FM	LOW period of the SCL clock	1.3	-	-	μs	
THIGHI2C_FM	HIGH period of the SCL clock	0.6	-	_	μs	
THDDATI2C	Data hold time	0	-	-	μs	
TSUDATI2C_FM	Data setup time	100	١	_	ns	
TSUSTOI2C_FM	Setup time for I <sup>2</sup> C STOP condition	0.6	-	_	μs	
CB_FM	Capacitive load for each I <sup>2</sup> C bus line	_	١	400	pF	
TVDDATI2C_FM	Data valid time	-	-	0.9	μs	
TVDACKI2C_FM	Data valid acknowledge time	_	١	0.9	μs	
TSPI2C_FM	Pulse width of spikes suppressed by the input filter	_	1	50	ns	
TBUFI2C_FM	Bus-free time between STOP and START condition	1.3	١	_	μs	
VIL_I2C	Input LOW voltage	-0.5	-	0.3 * V <sub>DD</sub>	V	2-mA sink
VIH_I2C	Input HIGH Voltage	0.7* V <sub>DD</sub>	-	_	V	3-mA sink
VOL_I2C_L	Output LOW voltage, low supply range	_	١	0.2 * V <sub>DD</sub>	V	V <sub>DD</sub> < 2 V, 3-mA sink
VOL_I2C_H	Output LOW voltage, high supply range	_	١	0.4	V	V <sub>DD</sub> > 2 V, 3-mA sink
IOL_I2C_FM	I <sup>2</sup> C output low current	6	_	_	mA	Fast Mode, 1.71 V ≤ V <sub>DD</sub> ≤ 5.5 V, load = CB_SM, V <sub>OL</sub> = 0.6 V
I2C_VHYS_HV	I <sup>2</sup> C input hysteresis	0.05 * V <sub>DD</sub>	-	-	mV	Fast and standard mode I2C speeds. 2 V $\leq$ V <sub>DD</sub> $\leq$ 4.5 V
I2C_VHYS_5V5	I <sup>2</sup> C input hysteresis	200	-	-	mV	Fast and standard mode I2C speeds. 4.5 V < V <sub>DD</sub> < 5.5 V
I2C_VHYS_LV	I <sup>2</sup> C input hysteresis	0.1 * V <sub>DD</sub>	_	_	mV	Fast and standard mode I2C speeds. V <sub>DD</sub> < 2 V



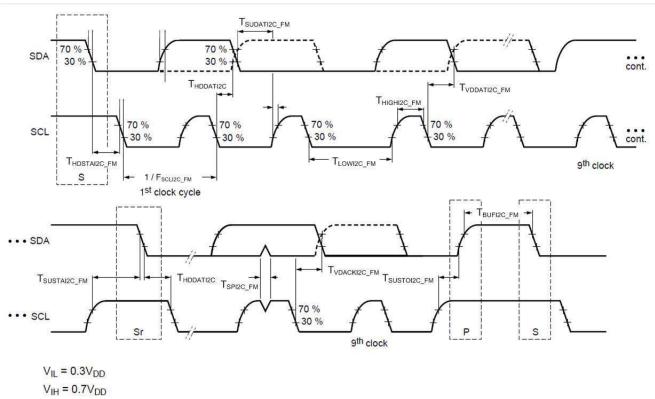


Figure 16. I<sup>2</sup>C Bus Timing Diagram for Fast or Standard Modes

# **System Specifications**

The specifications in the following table are valid at  $T_A$  = 25 °C and  $V_{DD}$  = 5 V, unless otherwise specified.

## Table 21. System Specifications

Parameter	Description	Conditions/Details	Min	Тур	Мах	Units
		0.2-pF sensitivity, SNR 5:1	5	Ι	45	pF
CP	Supported parasitic capacitance range of sensors	oported parasitic capacitance range of 0.1-pF sensitivity, SNR 5:1		Ι	35	pF
		0.1-pF sensitivity, SNR 4:1	5	Ι	45	pF
C <sub>MOD</sub>	Value for C <sub>MOD</sub> external capacitor	5-V rating, X7R or NP0 Cap. C <sub>P</sub> ≤ 45 pF	-	2.2	-	nF
I <sub>AVG_NT</sub>	Average current per button with no finger touch	V <sub>DD</sub> = 5 V, 3.3 V, 2.5 V, 1.8 V, C <sub>P</sub> = 10 pF, 2 buttons, Refresh interval = 120 ms, EMC disabled, 0.4-pF sensitivity	_	_	22	μΑ
I <sub>AVG_WT</sub>	Average current with finger touch	V <sub>DD</sub> = 5 V, 3.3 V, 2.5 V, 1.8 V, C <sub>P</sub> = 10 pF, 8 buttons, Refresh interval =120 ms, EMC disabled, 0.4-pF sensitivity	_	_	600	μΑ



### Table 21. System Specifications (continued)

Parameter	Description	Conditions/Details	Min	Тур	Max	Units
I <sub>AVG_WF</sub>	Average current with EMC	V <sub>DD</sub> = 5 V, 3.3 V, 2.5 V, 1.8 V, C <sub>P</sub> = 10 pF, 8 buttons, Refresh interval =120 ms, EMC enabled, 0.4-pF sensitivity	_	_	300	μΑ
I <sub>AVG_NF</sub>	Average current without EMC	V <sub>DD</sub> = 5 V, 3.3 V, 2.5 V, 1.8 V, C <sub>P</sub> = 10 pF, 8 buttons, Refresh interval = 120 ms, EMC disabled	-	-	100	μΑ
I <sub>DS</sub>	Deep Sleep current with I <sup>2</sup> C on	$V_{DD} \le 3.3 \text{ V}, \text{ T}_{A} = 25 \text{ °C}, \text{ I}^{2}\text{C} \text{ Enabled}$	-	2.5	-	μA
T <sub>BOOT_SYS</sub>	Boot-up time (time from power-up to first sensor scan) with system diagnostics enabled and EMC disabled	16 buttons, C <sub>P</sub> ≤ 18 pF	_	_	900	ms
T <sub>BOOT_WF</sub>	Boot-up time (time from power-up to first sensor scan) with no system diagnostics and EMC enabled	10 buttons, C <sub>P</sub> ≤ 18 pF	Ι	_	850	ms
Т <sub>воот</sub>	Boot-up time (time from power-up to first sensor scan) with no system diagnostics and EMC disabled	16 buttons, C <sub>P</sub> ≤ 18 pF	_	Ι	400	ms
T <sub>BOOT_SYS_WF</sub>	Boot-up time (time from power-up to first sensor scan) with both system diagnostics and EMC enabled.	10 buttons, C <sub>P</sub> ≤ 18 pF	Ι	_	1350	ms
T <sub>I2CBOOT</sub>	Boot up time (time from power to I <sup>2</sup> C ready)		-	-	15	ms
T <sub>I2C_LATENCY_</sub> MAX	Time between I <sup>2</sup> C command and execution (for all commands except the "Save" <sup>[20]</sup> command)		Ι	_	50	ms
т <sub>ні</sub>	Host interrupt pulse width	5 V, 1.8 V	200	-	700	μs
F <sub>BUZ_4</sub>	Buzzer output frequency	5 V, 1.8 V	-	4.00	-	kHz
F <sub>BUZ_2.67</sub>	Buzzer output frequency	5 V, 1.8 V	_	2.67	_	kHz
F <sub>BUZ_2</sub>	Buzzer output frequency	5 V, 1.8 V	_	2.00	_	kHz
F <sub>BUZ_1.60</sub>	Buzzer output frequency	5 V, 1.8 V	-	1.60	-	kHz
F <sub>BUZ_1.33</sub>	Buzzer output frequency	5 V, 1.8 V	-	1.33	-	kHz
F <sub>BUZ_1.143</sub>	Buzzer output frequency	5 V, 1.8 V	-	1.14	-	kHz
F <sub>BUZ_1</sub>	Buzzer output frequency	5 V, 1.8 V	-	1.00	Ι	kHz
F <sub>PWM</sub>	GPO PWM frequency	5 V, 1.8 V	-	106.7	-	Hz
T <sub>SNS_RST5</sub>	Sensor auto-reset interval 5 sec	5 V, 1.8 V	-	5	I	sec
T <sub>SNS_RST20</sub>	Sensor auto-reset interval 20 sec	5 V, 1.8 V	-	20	_	sec
T <sub>FAULTY_SNS_P</sub> ULSE	Pulse width on GPOx when the corresponding CSx fails the system diagnostics test		-	50	_	ms
C <sub>P_SHIELD</sub>	Maximum C <sub>P</sub> supported for shield electrode		_	-	100	pF



# **Power Consumption and Operational States**

The CY8CMBR3xxx family of controllers is designed with multiple low-power operational states to meet the low-power requirements of battery-powered applications. These controllers have the following operational states (see Figure 17):

- 1. Boot: The devices load the last-known configuration data and run system diagnostics tests.
- Active: The sensors are scanned at a fixed refresh rate to determine the presence of touch, proximity, or finger position on a slider, and any configured outputs (GPOs, buzzer and HI) are driven. The refresh time in this state is the total scanning and processing time of sensors, or 20 ms (typical) whichever is higher.
- 3. Look-for-Touch: All the sensors are scanned at a much slower, user-configured refresh interval, and any enabled GPOs (such as PWM or DC Toggle) are driven.
- Look-for-Proximity: Only proximity sensors enabled for wake-on approach are scanned. No outputs are driven in this state.
- 5. Deep Sleep: No sensors are scanned, and the CY8CM-BR3xxx devices are in a Low-power State with no processing. The GPO status is reset to the default value in the Deep Sleep mode.
- 6. Configuration: No scanning or reporting occurs and the devices wait for a reset for the configuration settings to take effect.

The CY8CMBR3xxx controllers automatically manage transitions between four operational states (Boot, Active, Look-for-Touch, and Look-for-Proximity). The host can force transition in and out of the Deep Sleep state. A host command can alter the configuration data, causing a transition to the Configuration state. A transition to Configuration state can also occur automatically after boot, if the configuration data is corrupted.

The Active state emphasizes a high refresh rate (that is, low refresh interval) for fast responses to button touches and proximity events. The Look-for-Touch state enables low power consumption during periods of no-touch activity.

The Look-for-Proximity state allows ultra-low power consumption when a human body is not in close proximity. This state is entered only if the wake-on-approach feature is enabled (and the toggle is disabled). In this state, the CY8CMBR3xxx controllers periodically scan proximity sensors to determine the presence of a human body. If they detect human presence, the controllers enter the Look-for-Touch state, in which they scan all sensors at a slow, user-configured refresh interval. If a touch is detected, the controllers enter the Active state. The controllers remain in the Active state as long as the touch is present. In this state, they update the sensor status and drive the corresponding outputs. A transition from Active to Look-for-Touch occurs when no touch is detected and the buzzer is not driven. Similarly, a transition from Look-for-Touch to Look-for-Proximity occurs when no proximity is detected.

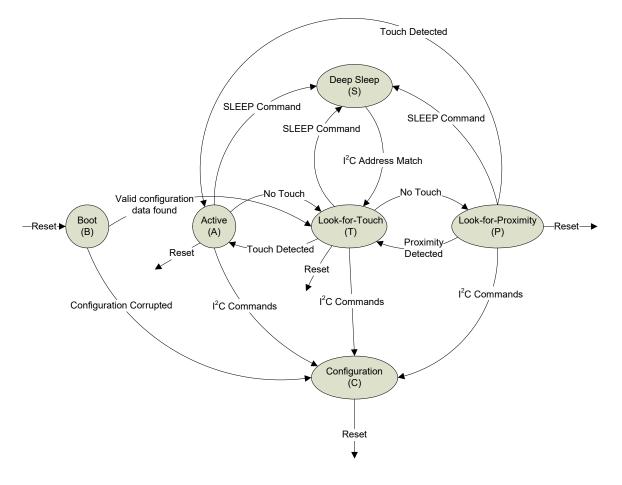
The following parameters configure the operational states:

- State timeout (Register STATE\_TIMEOUT) defines the following:
  - Image: Minimum time (in seconds) of no touch activity in the Active state
  - Inimum time to trigger a transition to the Look-for-Touch state
  - Minimum time of no touch activity in the Look-for-Touch state
  - Image: Minimum time to trigger a transition to the Look-for-Proximity state
- Refresh Interval (Register REFRESH\_CTRL) defines the minimum time between the start of subsequent scans in the Look for Touch and Look-for-Proximity states.
- The Refresh Interval for the Active state is fixed at 20 ms.

During all three operational states—Active, Look-for-Touch, and Look-for-Proximity, within each refresh interval, the devices enter a Low-power State after scanning and processing the requisite sensors. This helps to maintain the lowest average power consumption within any refresh interval. Note that if any I<sup>2</sup>C traffic is detected on the I<sup>2</sup>C bus or the I2C\_SCL is held low, the devices do not enter the Low-power State after scanning and processing the sensors. This ensures that the devices do not send unnecessary NACKs to I<sup>2</sup>C transactions because of periodical entry to the Low-power State. Therefore, the device requires I<sup>2</sup>C interface to be in "free" state and I<sup>2</sup>C lines to be pulled up for power optimization.

Refer to section "System Design Recommendations for Low Power Consumption" in CY8CMBR3xxx CapSense Design Guide for low power design considerations.





# Figure 17. CY8CMBR3xxx Operational States and Transitions



# **Response Time**

Response time for button and proximity sensors is the minimum amount of time for which the sensor must be active/inactive (touched or proximity present), for the device to detect it as a valid activation or deactivation event.

For the CY8CMBR3xxx device family, response time numbers for different sensors can be estimated using the design toolbox. The following response time numbers are provided in the toolbox:

- R<sub>FBT</sub>: This value represents the response time for first button touch when the device is in the Look-for-Touch or Look-for-Proximity operational states.
- R<sub>CBT</sub>: This value represents the response time for consecutive button touches when the device is in the Active operational state.
- R<sub>FST</sub>: This value represents the response time for the first slider touch when the device is in the Look-for-touch operational state.
- R<sub>CST</sub>: This value represents the response time for consecutive slider touches when the device is in the Active operational state.
- R<sub>BSR</sub>: This value represents the response time for button and slider release events when the device is in the Active operational state.
- RProx: This value represents the response time for detecting valid proximity events on a proximity sensor.
- RProx\_release: This value represents the response time for proximity release events on a proximity sensor.

# CY8CMBR3xxx Resets

The CY8CMBR3xxx family of CapSense controllers has three reset options – two hardware resets and one software reset.

- Hardware Resets
  - Power reset –Toggling the power on the V<sub>DD</sub> pin of the Cap-Sense controller resets the controller.
  - INTERSTITE TRANSPORTED TRAN

#### Software Reset

To reset the software, write one SW\_RESET command to the command register. All three resets are functionally equivalent, and the CapSense controllers enter the Boot state (refer to the Power Consumption and Operational States section) after any reset.

# **Host Communication Protocol**

The CY8CMBR3xxx CapSense controllers communicate to the host through the  $I^2C$  interface.  $I^2C$  is a simple two-wire synchronous communication protocol that uses the following two lines:

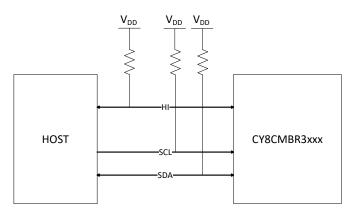
- Serial Clock (SCL) This line is used to synchronize the slave with the master.
- Serial Data (SDA) This line is used to send data between the master and the slave.

The CY8CMBR3xxx I<sup>2</sup>C interface has the following features:

- Bit rate of 400 kbps
- Configurable I<sup>2</sup>C slave address (7-bit)
- No bus-stalling or clock-stretching during transactions
- Register-based access to the I<sup>2</sup>C master for reads and writes
- Repeated START support

The CY8CMBR3xxx CapSense controllers can be part of a single-slave or a multi-slave environment.

# Figure 18. I<sup>2</sup>C Communication Between One Master and One Slave



# I<sup>2</sup>C Slave Address

To identify each device on the  $I^2C$  bus, a unique 7-bit  $I^2C$  slave address is used. When the master wants to communicate with a slave on the bus, it sends a START condition followed by the appropriate  $I^2C$  address. The START condition alerts all slaves on the bus when a new transaction starts. The slave with the specified  $I^2C$  address acknowledges the master. All the other slaves ignore further traffic on the bus until the next START condition is detected.

The 7-bit I2C Slave Address for CY8CMBR3xxx devices can be configured by modifying the contents of I2C\_ADDR register mentioned in CY8CMBR3xxx Registers TRM. Refer to section "Configuring CY8CMBR3xxx" in CY8CMBR3xxx CapSense Design Guide for more details on how to configure CY8CM-BR3xxx registers.

The I2C address can be configured to any value between 0x08 to 0x77. The default I2C address for all CY8CMBR3xxx devices is 0x37.



# I<sup>2</sup>C Communication Guidelines

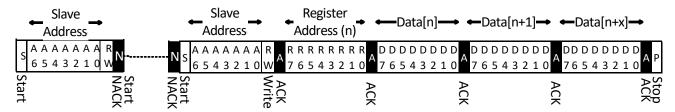
- After device reset, the host should wait for T<sub>I2CBOOT</sub> time before initiating any I<sup>2</sup>C communication. The CY8CMBR3xxx CapSense controller family will generate a NACK if the host tries to communicate before this period.
- 2. The CY8CMBR3xxx controller is expected to NACK the address match event if it is in the low-power state (during any of the operational states – Deep Sleep, Look-for-Touch, Look-for-Proximity, or Active). The controller wakes up from the low-power state on an address match but sends NACK until it transitions into the Active state and, on for the first transaction, in the active state. When the device NACKs a transaction the host is expected to retry the transaction until it receives an ACK.
- If there is a delay of more than 340 ms between two subsequent bytes within an I<sup>2</sup>C transaction, the device may go into low-power state and the host may get a NACK.
- 4. When the host sends the SAVE\_CHECK\_CRC command, the device will send a NACK on any subsequent I<sup>2</sup>C transactions until the command execution is completed. The time taken to complete the SAVE\_CHECK\_CRC command is 220 ms typ.
- 5. The host must not write to read-only registers. All write operations directed to such read-only registers are ignored.

# Write Operation

A host performs the following steps during a write operation:

- 1. The host sends the START condition.
- 2. The host specifies the slave address, followed by the read/write bit to specify a write operation.
- 3. The device may NACK the host.
- 4. The host sends a Repeat Start (or a stop followed by a start condition), followed by the address and read/write bit, to specify a write operation. The host keeps sending the Repeat Start with the address and read/write bits until the device sends an ACK. The device ACKs the host.
- 5. The host specifies the register address to which it has to write.
- 6. The device ACKs the host.
- 7. The host starts sending the data to the device, which is written to the register address specified by the host. This is followed by an ACK from the device.
- 8. If the write operation includes more bytes, each one is written to the successive register address. Each successive byte is followed by an ACK from the device.
- 9. After the write operation is complete, the host sends the STOP condition to the device. This marks the end of the communication (see Figure 19).

#### Figure 19. Host Writing x Bytes to the Device



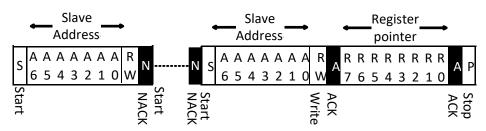
### Setting the Device Data Pointer

The host sets the device data pointer to specify the starting point for future read operations. Setting the device data pointer involves the following steps:

- 1. The host sends the START condition.
- 2. The host specifies the slave address, followed by the read/write bit to specify a write operation.
- 3. The device may NACK the host.

- 4. The host sends a Repeat Start, followed by the address and read/write bit, to specify a write operation. The host keeps sending the repeat start with the address and read/write bit until the device sends an ACK.
- 5. The device ACKs the host.
- 6. The host specifies the register address. Any further read operation will take place from this address.
- 7. The host sends the STOP condition (see Figure 20).

#### Figure 20. Host Setting the Device Data Pointer



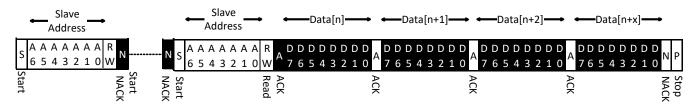


# **Read Operation**

The host performs the following steps for a read operation:

- 1. The host sends the START condition.
- 2. The host specifies the slave address, followed by the read/write bit to specify a write operation.
- 3. The device may NACK the host.
- 4. The host sends a repeat start followed by the address and read/write bit to specify a write operation. The host keeps sending the repeat start with the address and read/write bits until the device sends an ACK.
- 5. The device ACKs the host.

- 6. The device retrieves the byte from the pre-specified register address and sends it to the host. The host ACKs the device.
- 7. Each successive byte is retrieved from the successive register address and sent to the host, followed by ACKs from the host.
- 8. After the host receives the required bytes, it NACKs the device.
- 9. The host sends the STOP condition to the device. This marks the end of the communication (see Figure 21).



Legend:

CY8CMBR3xxx to Host
HOST to CY8CMBR3xxx

### Figure 21. Host Reading x Bytes from the Device



# Layout Guidelines and Best Practices

Cypress provides an extensive set of design guidelines for CapSense board designs. Refer to the CY8CMBR3xxx CapSense Design Guide for complete system guidelines. For a summary schematic and layout checklist, refer Table 3-2. Schematic Design Checklist and Table 4-1. Layout Recommendations in this Design Guide.

# Ordering Information

\_ . . . . . . .

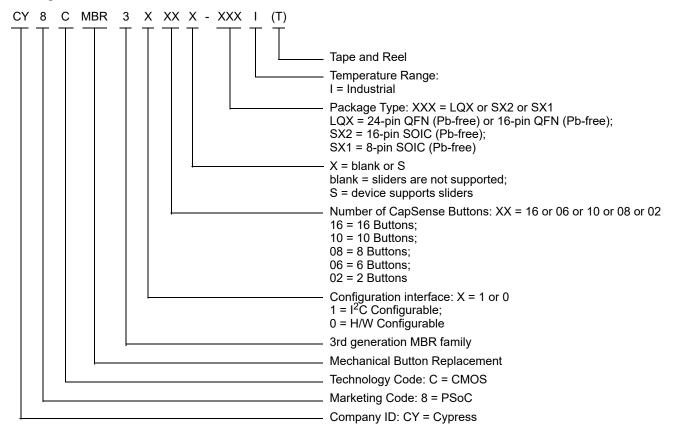
The CY8CMBR3xxx family consists of six parts that vary depending on the parameters. The following table lists all the parts and a summary of the features supported. All package types are also available in Tape and Reel.

Table 22. 0	Ordering	Informati	ion
-------------	----------	-----------	-----

. .

Ordering Code	Package Type	Operating Temperature	Total Capacitive Sensing Inputs	CapSense Buttons	Sliders	Proximity Sensors	GPOs	Shield	Communication Interface
CY8CMBR3116-LQXI	24-pin QFN	Industrial	Up to 16	Up to 16	0	Up to 2	Up to 8	1	l <sup>2</sup> C / GPO
CY8CMBR3106S-LQXI	24-pin QFN	Industrial	Up to 16	Up to 11	Up to 2	Up to 2	0	1	l <sup>2</sup> C
CY8CMBR3110-SX2I	16-pin SOIC	Industrial	Up to 10	Up to 10	0	Up to 2	Up to 5	1	l <sup>2</sup> C / GPO
CY8CMBR3108-LQXI	16-pin QFN	Industrial	Up to 8	Up to 8	0	Up to 2	Up to 4 + HI	1	I <sup>2</sup> C / GPO
CY8CMBR3102-SX1I	8-pin SOIC	Industrial	Up to 2	Up to 2	0	Up to 2	Up to 1	1	l <sup>2</sup> C/GPO
CY8CMBR3002-SX1I	8-pin SOIC	Industrial	2	2	0	0	2	0	GPO

## **Ordering Code Definitions**





# **Packaging Dimensions**

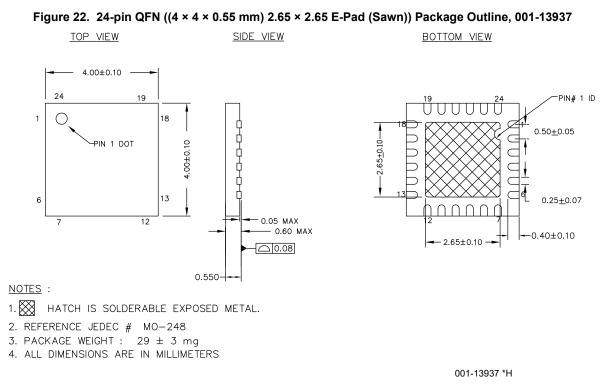
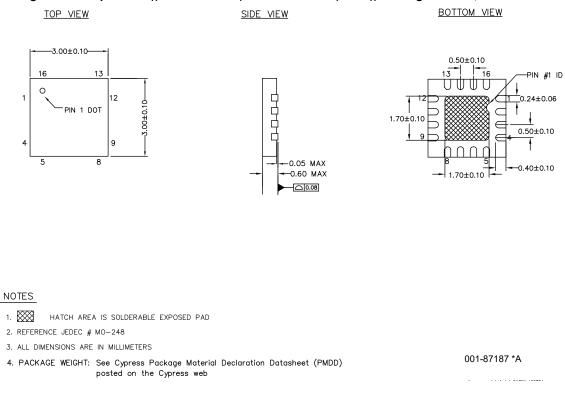


Figure 23. 16-pin QFN ((3 × 3 × 0.6 mm) 1.7 × 1.7 E-Pad (Sawn)) Package Outline, 001-87187





### Figure 24. 16-pin SOIC (150 Mils) Package Outline, 51-85068

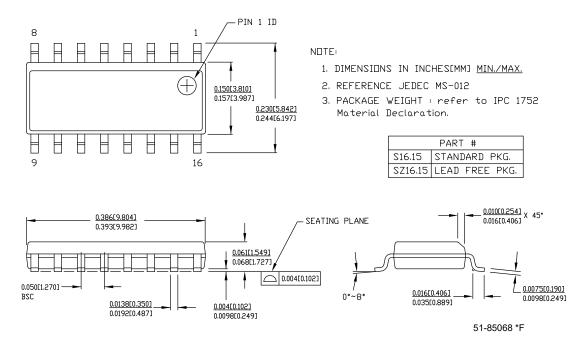


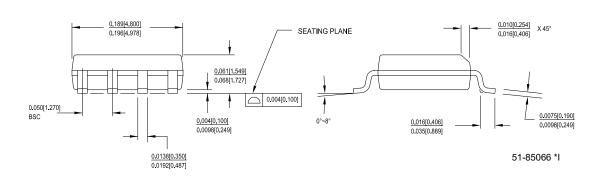
Figure 25. 8-pin SOIC (150 Mils) Package Outline, 51-85066

1. DIMENSIONS IN INCHES[MM] MIN. MAX.

- 2. PIN 1 ID IS OPTIONAL, ROUND ON SINGLE LEADFRAME RECTANGULAR ON MATRIX LEADFRAME
- 3. REFERENCE JEDEC MS-012

4. PACKAGE WEIGHT 0.07gms

PART #			
S08.15	STANDARD PKG		
SZ08.15	LEAD FREE PKG		
SW8.15	LEAD FREE PKG		



4

5

1

8

PIN 1 ID

0.150[3.810] 0.157[3.987]

> 0.230[5.842] 0.244[6.197]



# **Thermal Impedances**

### Table 23. Thermal Impedances

Parameter	Description	Conditions	Min	Тур	Max	Units
T <sub>A</sub>	Operating ambient temperature		-40	25	85	°C
TJ	Operating junction temperature		-40	-	100	°C
T <sub>JA</sub>	Package θ <sub>JA</sub> (24-pin QFN)		-	38	-	°C/Watt
T <sub>JC</sub>	Package θ <sub>JC</sub> (24-pin QFN)		-	5.6	-	°C/Watt
T <sub>JA</sub>	Package θ <sub>JA</sub> (16-pin QFN)		-	49.6	-	°C/Watt
T <sub>JC</sub>	Package θ <sub>JC</sub> (16-pin QFN)		-	5.9	-	°C/Watt
T <sub>JA</sub>	Package θ <sub>JA</sub> (16-pin SOIC)		-	142	-	°C/Watt
T <sub>JC</sub>	Package θ <sub>JC</sub> (16-pin SOIC)		-	49.8	-	°C/Watt
T <sub>JA</sub>	Package θ <sub>JA</sub> (8-pin SOIC)		-	198	-	°C/Watt
T <sub>JC</sub>	Package θ <sub>JC</sub> (8-pin SOIC)		-	56.9	_	°C/Watt

### **Solder Reflow Specifications**

Table 24 illustrates the minimum solder reflow peak temperature to achieve good solderability.

### Table 24. Solder Reflow Specifications

Package	Maximum Peak Temperature	Time at Maximum Temperature
8-pin SOIC	260 °C	30 s
16-pin SOIC	260 °C	30 s
16-pin QFN	260 °C	30 s
24-pin QFN	260 °C	30 s



# **Document Conventions**

### **Units of Measure**

# Table 25. Units of Measure

Symbol	Units of Measure
°C	degrees Celsius
fF	femtofarad
Hz	hertz
kbps	kilobits per second
kHz	kilohertz
kΩ	kilo ohm
MHz	megahertz
μA	microampere
μF	microfarad
μs	microsecond
mA	milliampere
ms	millisecond
mV	millivolt
nA	nanoampere
ns	nanosecond
nV	nanovolt
Ω	ohm
рр	peak-to-peak
pF	picofarad
s	second
V	volt



# Glossary

C	
С <sub>Р</sub>	Parasitic capacitance.
EZ-Click	The customizer tool (GUI) that enables easy register configurability and debugging for the CY8CM- BR3xxx family of controllers.
GPO	General Purpose Output – that is, an output pin on a chip that the user can configure.
FSS	Flanking Sensor Suppression. An algorithm that distinguishes between signals from closely spaced buttons, eliminating false touches. It ensures that the system recognizes only the first button touched.
SmartSense	Cypress CapSense algorithm that continuously compensates for system, manufacturing, and environmental changes.
SNR	A ratio of the sensor signal, when touched, to the noise signal of an untouched sensor.
Toggle	An MBR device feature that toggles the state of GPOs on every sensor activation.
Open-Drain Low-Drive mode	An output pin drive mode wherein logic 0 is represented by a low voltage (that is, Voltage < $V_{OL}$ ), whereas logic 1 is represented by floating the output line to a HIGH impedance state.
Strong Drive mode	An output pin drive mode where logic 0 is represented by a low voltage (that is, Voltage < $V_{OL}$ ), whereas logic 1 is represented by a high voltage (that is, Voltage V > $V_{OH}$ ).
Raw counts	A count value representing a digital count equivalent of sensed capacitance.
Baseline	A filtered version of the raw counts. The baseline essentially tracks the value of the parasitic capacitance in the system but does not track the value of the finger capacitance.
Parasitic capacitance	The intrinsic capacitance of PC board traces to sensors.
Finger capacitance	Additional capacitance introduced on a CapSense sensor when a finger approaches/touches the sensor.
Global setting	A setting value that is common for all elements of a set.
Active LOW signal	A signal that indicates the active state by logic 0 and the inactive state by logic 1 values.
Active HIGH signal	A signal that indicates the active state by logic 1 and the inactive state by logic 0 values.
Low-power State	A state where the device does not perform any processing and hence consumes less power.

# **Reference Documents**

Document Title	Description
CapSense CY8CMBR3xxx Design Guide	Provides design guidance for using capacitive touch sensing (CapSense) function- ality with the CY8CMBR3xxx family of CapSense controllers.
Getting Started with CapSense®	Provides a starting point for anyone who is new to capacitive touch sensing (CapSense) and for anyone learning key design considerations and layout best practices.
Design Toolbox	Includes four sections – General Layout Guidelines for a CapSense PCB, a layout estimator for estimating button dimensions, a power consumption calculator (based on button dimensions), and the Design Validation tool to validate the layout design.
EZ-Click User Guide	Gives instructions on how to install and uninstall the EZ-Click Customizer tool and describes how to set up the boards. It also includes detailed descriptions of all the tabs in the GUI.
CY8CMBR3xxx Programming Specifications	Gives the information necessary to program the nonvolatile memory of the CY8CM- BR3xxx devices. It describes the communication protocol required for access by an external programmer, explains the programming algorithm, and gives electrical specifications of the physical connection.
CapSense® Express™ Controllers Registers TRM	Lists and details all registers of CY8CMBR3102, CY8CMBR3106S, CY8CM- BR3108, CY8CMBR3110, and CY8CMBR3116 CapSense <sup>®</sup> Express™ controllers. All registers are listed in the order of address.



# **Document History Page**

Document Title: CY8CMBR3002/CY8CMBR3102/CY8CMBR3106S/CY8CMBR3108/CY8CMBR3110/CY8CMBR3116 Datasheet CapSense Express Controllers with SmartSense Auto-tuning 16 Buttons, 2 Sliders, Proximity Sensors Document Number: 001-85330				
Revision	ECN	Submission Date	Description of Change	
*G	4359354	05/06/2014	Updated hyperlinks for the following web pages namely "EZ-Click Customizer Tool", "Cypress online store", and "CY3280-MBR3 Evaluation Kit". Updated Packaging Dimensions: Updated Table 24: Replaced 20 seconds with 30 seconds in "Time at maximum temperature" column.	
*H	4557306	11/26/2014	Replaced the term "water tolerance" with "liquid tolerance" wherever applicable. Updated Features Overview: Added MPN versus Features Summary. Updated Pinouts: Updated Pinouts: Updated Table 1: Corrected pin naming in the CY8CMBR3116 pin diagram. Updated details in "If unused" column corresponding to I2C SDA and I2C SCL pins. Added Note 1 and referred the same note in CS6 pin. Updated CY8CMBR31065 (16 Sensing Inputs; Silders Supported): Updated CY8CMBR31085 (16 Sensing Inputs; Silders Supported): Updated CY8CMBR3108 (8 Sensing Inputs): Updated CY8CMBR3108 (8 Sensing Inputs): Updated CY8CMBR3108 (8 Sensing Inputs): Updated Table 3: Updated Table 3: Updated Table 3: Updated Table 4: Updated Table 4: Updated Table 4: Updated Table 5: Updated Table 4: Updated Table 5: Updated CY8CMBR3102 (2 Sensing Inputs): Updated Table 5: Updated CY8CMBR3002 (2 Sensing Inputs): Updated Table 5: Updated Table 5: Updated CY8CMBR3002 (2 Sensing Inputs): Updated CY8CMBR3002 (2 Sensing Inputs): Updated Table 5: Updated Table 6: Referred Note 8 and referred the same note in CS0/PS0 pin. Updated Dable 6: Referred Note 8 in CS0 pin. Updated Davice Feature Details: Updated description. Updated description. Updated Able 6: Referred Note 8 in CS0 pin. Updated description. Updated Motise Immunity: Updated description. Updated Able for IO and referred the same note in "Sensor shorted to V <sub>SS</sub> ". Added Note 10 and referred the same note in "Sensor shorted to V <sub>SS</sub> ". Added Note 10 and referred the same note in "Sensor shorted to V <sub>SS</sub> ". Added Able for Communication Protocol: Updated Able for Communication Protocol: Updated Able 7 – Changed revision from ** to *A. Updated Packaging Dimensions: spec 001-87187 – Changed revision from ** to *A. Updated Gintinion of "low-power state".	
*	4626833	01/16/2015	Added More Information. Moved CY8CMBR3xxx Ecosystem section to page 2.	



# Document History Page (continued)

Revision	ECN	Submission Date	Description of Change	
*J	4681058	03/10/2015	Updated Ordering Information: Added Note "All package types are available in Tape and Reel." and referred the same note in Table 22. Added Ordering Code Definitions.	
*К	4735762	05/07/2015	Updated Packaging Dimensions: spec 001-13937 – Changed revision from *E to *F. Updated Thermal Impedances: Updated Table 23: Updated entire table.	
*L	4812567	06/26/2015	Updated MPN versus Features Summary: Updated details in "CY8CMBR3002" column corresponding to "Sensor auto-reset" feature. Updated details in "CY8CMBR3108" column corresponding to "Maximum number of GPOs/LED drive outputs" feature. Updated Pinouts: Recommended "If unused" connection for SPO, GPO and AXRES pins. Added Unused SPO Pin Connection. Added Unused SPO Pin Connection for AXRES pins. Added Unused GPO Pin Connection. Updated Power Consumption and Operational States: Removed low power design guidelines from this section, and referred to CY8CMBR3xxx Design Guide for these guidelines. Updated I2C Slave Address: Mentioned default I2C slave address for CY8CMBR3xxx devices. Provided details on how to configure the 7-bit I2C slave address for CY8CMBR3xxx devices.	
*M	5041506	01/13/2016	Updated Power Supply Information: Updated description. Updated Power Consumption and Operational States: Updated description. Updated Figure 17. Updated Ordering Information: Removed the Note "All package types are available in Tape and Reel." and its reference i Table 22, rather mentioned the same in description above Table 22. No change in part numbers. Updated Ordering Code Definitions (Added (T) and its details). Updated Packaging Dimensions: spec 51-85066 – Changed revision from *G to *H. Updated to new template.	
*N	5638290	03/16/2017	Removed spec R <sub>PU</sub> . Added Flash Specifications. Updated Figure 16 Add Rpullup in XRES DC Specifications. Updated to new template.	
*0	6032718	01/15/2018	Updated Packaging Dimensions: spec 51-85066 – Changed revision from *H to *I.	



# Document History Page (continued)

Revision	ECN	Submission Date	Description of Change
*P	6841442	03/30/2020	Updated Pinouts: Updated CY8CMBR3108 (8 Sensing Inputs): Updated Table 3: Included "I/DO" under "Type" column corresponding to CS5/GPO1pin. Included "DO = Digital Output" in the bottom of the table. Updated CY8CMBR3110 (10 Sensing Inputs): Updated Table 4: Included "DO = Digital Output" in the bottom of the table. Updated CY8CMBR3102 (2 Sensing Inputs): Updated Table 5: Included "DO = Digital Output" in the bottom of the table. Updated Table 5: Included "DO = Digital Output" in the bottom of the table. Updated Layout Guidelines and Best Practices: Added "For a summary schematic and layout checklist, refer Table 3-2. Schematic Design Checklist and Table 4-1. Layout Recommendations in this Design Guide." in the end of paragraph. Updated Packaging Dimensions: spec 001-13937 – Changed revision from *F to *H. spec 51-85068 – Changed revision from *E to *F. Updated to new template. Completing Sunset Review.
*Q	7104675	03/15/2021	Updated the description of the T <sub>SR POWER UP</sub> parameter.



# Sales, Solutions, and Legal Information

### Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

#### Products

Arm <sup>®</sup> Cortex <sup>®</sup> Microcontrollers	cypress.com/arm
Automotive	cypress.com/automotive
Clocks & Buffers	cypress.com/clocks
Interface	cypress.com/interface
Internet of Things	cypress.com/iot
Memory	cypress.com/memory
Microcontrollers	cypress.com/mcu
PSoC	cypress.com/psoc
Power Management ICs	cypress.com/pmic
Touch Sensing	cypress.com/touch
USB Controllers	cypress.com/usb
Wireless Connectivity	cypress.com/wireless

# **PSoC<sup>®</sup> Solutions**

PSoC 1 | PSoC 3 | PSoC 4 | PSoC 5LP | PSoC 6 MCU

#### **Cypress Developer Community**

Community | Code Examples | Projects | Video | Blogs | Training | Components

#### **Technical Support**

cypress.com/support

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. No computing device can be absolutely secure. Therefore, despite security measures implemented in Cypress hardware or software products, Cypress shall have no liability arising out of any security breach, such as unauthorized access to or use of a Cypress product. CYPRESS DOES NOT REPRESENT, WARRANT, OR GUARANTEE THAT CYPRESS PRODUCTS, OR SYSTEMS CREATED USING CYPRESS PRODUCTS, WILL BE FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION (collectively, "Security Breach"). Cypress disclaims any liability relating to any Security Breach, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from any Security Breach. In events and described in these materials may contain design defects or errors known as errata which may cause the product to deviate from published specifications. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. "High-Risk Device" means any device or system whose failure could cause personal injury, death, or properly damage. Examples of High-Risk Devices are weapons, nuclear installations, surgical implants, and other medical devices. "Critical Component" means any component of a High-Risk Device whose failure to perform can be reasonably expected to cause, directly or indirectly, the failure of the High-Risk Device, or to affect its safety or effectiveness. Cypress is not liable,

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, WICED, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.

Document Number: 001-85330 Rev. \*Q

<sup>©</sup> Cypress Semiconductor Corporation, 2013–2021. This document is the property of Cypress Semiconductor Corporation and its subsidiaries ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property jaws and treaties of the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.